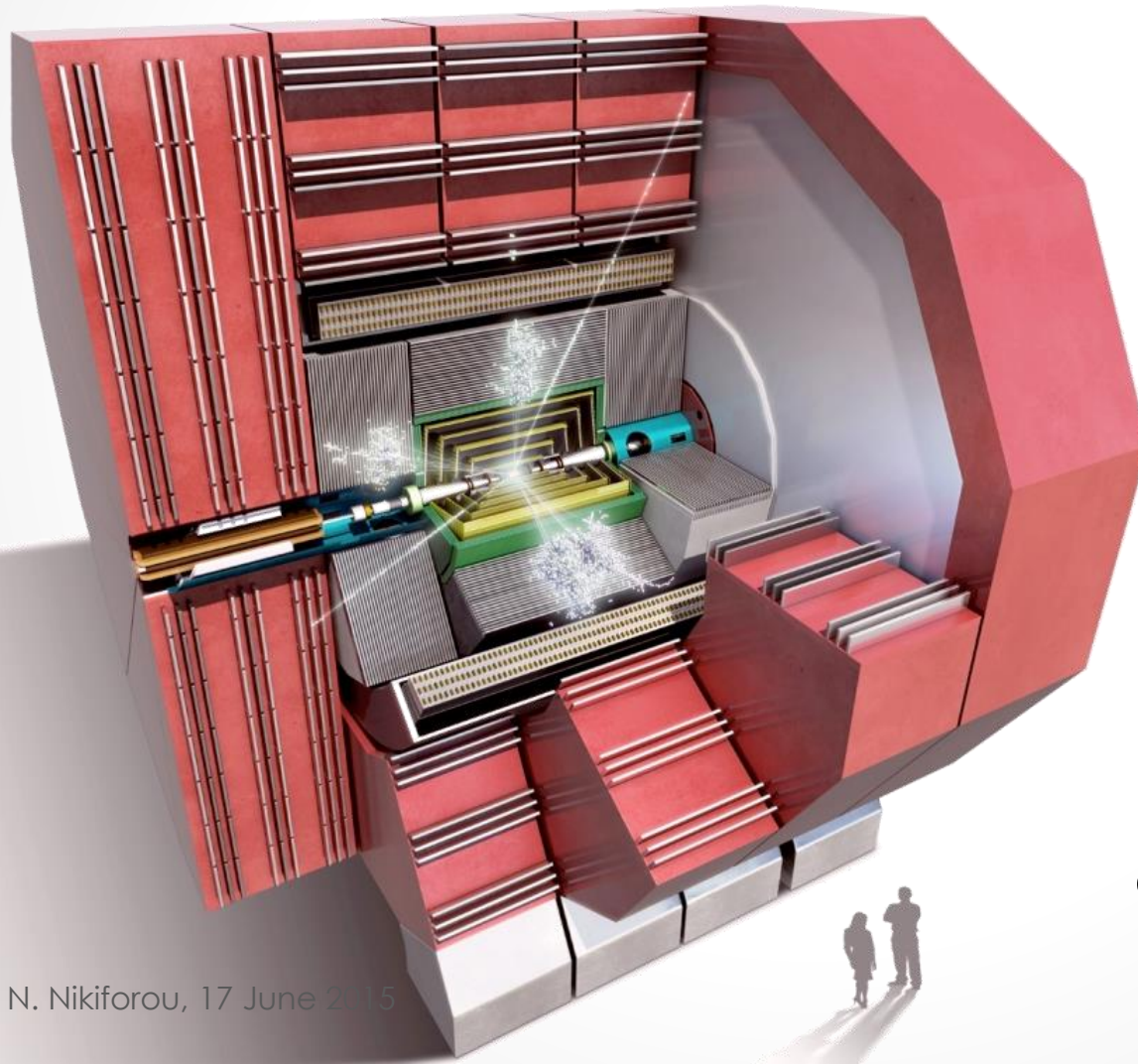


The new CLIC Detector Simulation Model with Full Silicon Tracking



Nikiforos Nikiforou
CERN/PH-LCD
on behalf of the
CLICdp collaboration



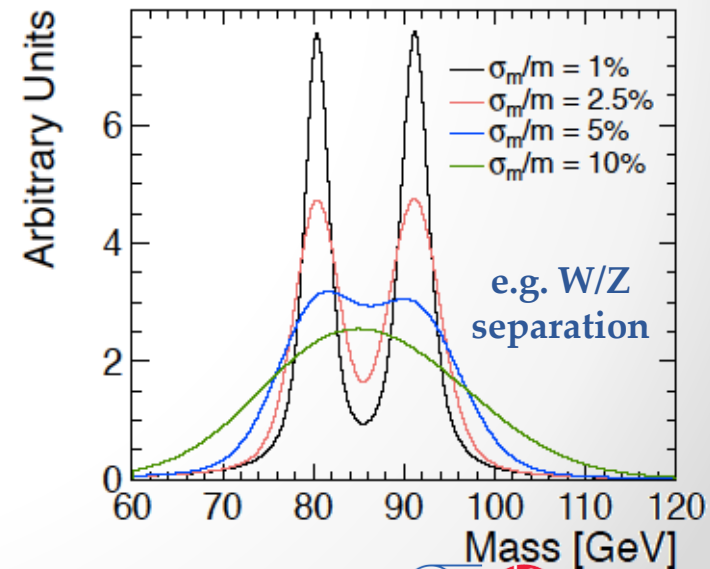
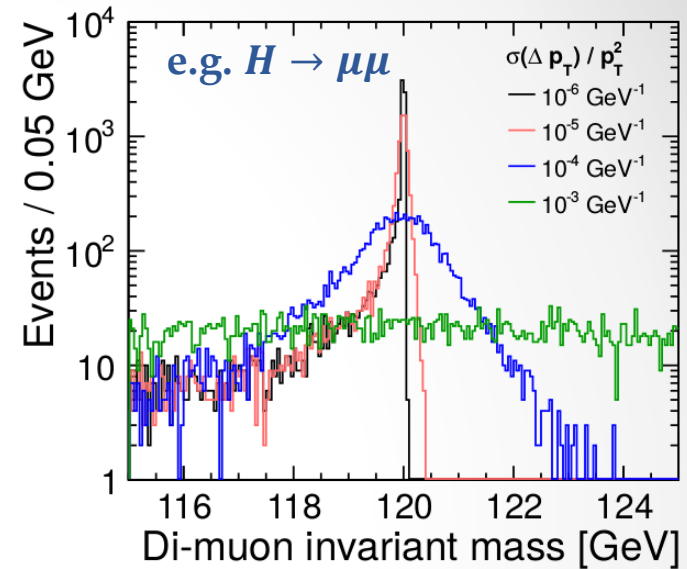
1st FCC-ee mini-Workshop
on Detector Requirements
CERN, June 17th 2015

Outline

- Detector requirements and experimental conditions
- Evolution of detector models since the CDR
- CLIC detector concept and ongoing optimization efforts
- Implementation in Software
- Conclusions

CLIC Physics Goals → Detector Requirements

- Momentum resolution
 - Higgs recoil mass, smuon endpoint, **Higgs coupling to muons**
 $\rightarrow \sigma_{p_T}/p_T^2 \sim 2 \times 10^{-5} \text{ GeV}^{-1}$
- Jet energy resolution
 - **Separation of W/Z/H di-jets**
 $\rightarrow \sigma_E/E \sim 3.5\%$ for $E > 100 \text{ GeV}$
- Impact parameter resolution
 - c/b -tagging, Higgs branching ratios
 $\rightarrow \sigma_{r_\phi} \sim 5 \oplus 15 / (p[\text{GeV}] \sin^{\frac{3}{2}} \theta) \mu\text{m}$
- Angular coverage
 - Very forward electron tagging
 \rightarrow Down to $\theta = 10 \text{ mrad}$
- + Requirements due to CLIC beam structure and beam-induced backgrounds



The CLIC Experimental Environment

CLIC at 3 TeV	
Luminosity	$5.9 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$
Bunch separation	0.5 ns
#Bunches per train	312
Train duration	156 ns
Train repetition rate	50 Hz
Particles per bunch	3.72×10^9
Crossing angle	20 mrad
σ_x / σ_y [nm]	$\approx 45 / 1$
σ_z [μm]	44

Drive **timing requirements** for the CLIC detector

Low duty cycle

- Triggerless readout
- Power pulsing (turning power off when not needed)

Very small beam profile at the interaction point
 \Rightarrow Very high E-fields \Rightarrow
Beam-beam background

CLIC bunch structure

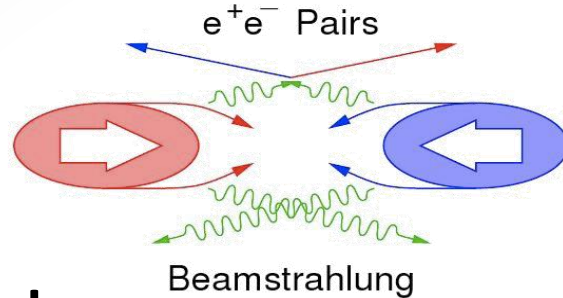
- not to scale -

• N. Nikiforou, 17 June 2015



.....
1 train = 312 bunches, 0.5 ns apart

Beam-Induced Backgrounds



- **Beamstrahlung:**

- **Pair-background**

- **Coherent e^+e^- pairs:** $7 \times 10^8/\text{BX}$

- Very forward

- **Incoherent e^+e^- pairs:** $3 \times 10^5/\text{BX}$

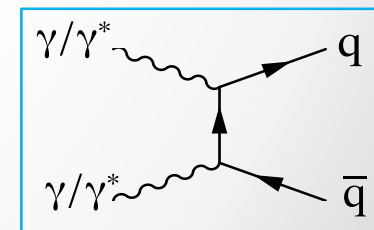
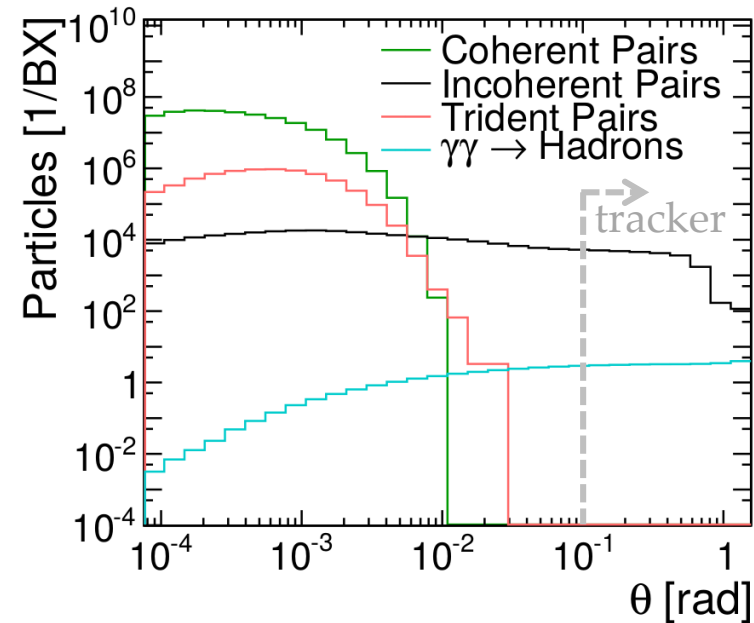
- Rather forward

- High occupancies **influence detector design**

- **$\gamma\gamma$ to hadrons (3.2 events/BX @ 3 TeV)**

- Energy deposits (19 TeV/train @ 3 TeV)

- Main background in calorimeters and trackers



Evolution of Detector Designs

For the CLIC CDR (2012): Two general-purpose CLIC detector concepts

- Based on initial ILC concepts (ILD and SiD) but Optimized and adapted to CLIC conditions

Concept\	ILD (ILC)	CLIC_ILD	SiD (ILC)	CLIC_SiD	New Model	CMS†
Tracker	TPC/Silicon	TPC/Silicon	Silicon	Silicon	Silicon	Silicon
Solenoid Field [T]	3.5	4	5	5	4	3.8
Solenoid Free Bore [m]	3.3	3.4	2.6	2.7	3.4	3.0
Solenoid Length [m]	8	8.3	6	6.5	8.3	13
VTX Inner Radius [mm]	16	31*	14	27*	31*	40
ECAL Inner Radius [m]	1.8	1.8	1.3	1.3	1.5	1.3
ECAL ΔR [mm]	172	172	135	135	159	500
HCAL Absorber B / E	Fe	W / Fe	Fe	W / Fe	Fe	Brass
HCAL λ_i	5.5	7.5	4.8	7.5	7.55	5.8 Barrel/10 EC
Overall Height [m]	14	14	12	14	14	14.6
Overall Length [m]	13.2	12.8	11.2	12.8	10.4	21.6

* For $\sqrt{s} \lesssim 500$ GeV a variant with a VTX inner radius smaller by 6 mm is used

† See [\[16\]](#) for a nice comparison of CLIC and LHC detectors

CLIC Detector Performance Figures Twiki

https://twiki.cern.ch/twiki/bin/view/CLIC/ClicNDM_PerformanceNumbers

Detector Characteristics Requested by FCC-ee

↓ [Detector Characteristics Requested by FCC-ee](#)

↓ [Basic geometry:](#)

↓ [Radius of tracking system](#)

↓ [Vertex Detector](#)

↓ [Silicon Tracker:](#)

↓ [Length of magnetic field coverage](#)

↓ [Magnetic field intensity:](#)

↓ [Tracking coverage in eta/theta](#)

↓ [Eta/phi granularity of hcal and ecal](#)

↓ [Momentum resolution formula for charged tracks](#)

↓ [energy resolution for electrons and photons](#)

↓ [momentum resolution for muons](#)

↓ [Impact parameters resolution](#)

↓ [identification and mis-identification efficiency for particles: muons, electron, pions, kaons, ...](#)

↓ [neutral hadron energy fraction lost in hcal and ecal \(sum =1\)](#)

↓ [energy resolution formula for jets](#)

↓ [b-tag efficiency \(optional\)](#)

- Performance figures collected in twiki
- For reference and/or perhaps use in fast sim
- Most of them are there, with some references
- Others to come

Basic geometry:

Radius of tracking system

Vertex Detector

- Barrel: 3 double layers Pixels with 3 micrometer resolution
 - Rin = 30.825 mm
 - Rout= 60 mm
 - MaxZ= 130 mm
- Endcap: Double layers where petals are arranged in a "Spiral" geometry. Pixels with 3 micrometer resolution
 - Min z: 160 mm
 - Max z: 298.8 mm
 - Min r: 33 mm
 - Max r: 102 mm
 - Dz between first and last sensitive layer: 136 mm
 - Petal angle: 45 degree

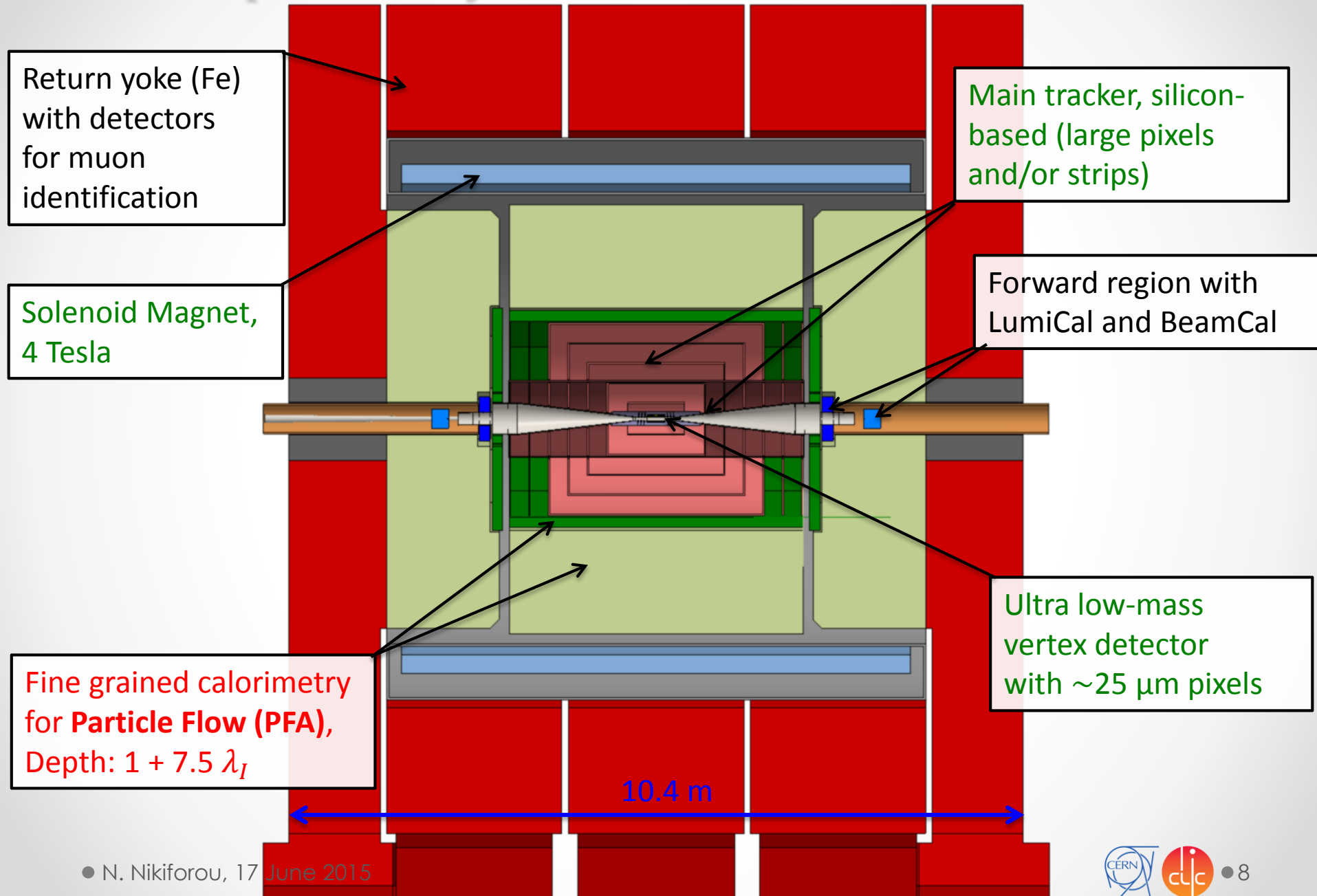
Silicon Tracker:

Technology not decided yet, should be either "large" pixels or short strips, or a combination of the two. Will comprise an "Inner Tracker" and an "Outer Tracker" in the barrel.

- Rin=61 mm
- Rout=1500 mm

● N. Nikiforou, 17 June 2015

Proposed Layout in New Detector Model

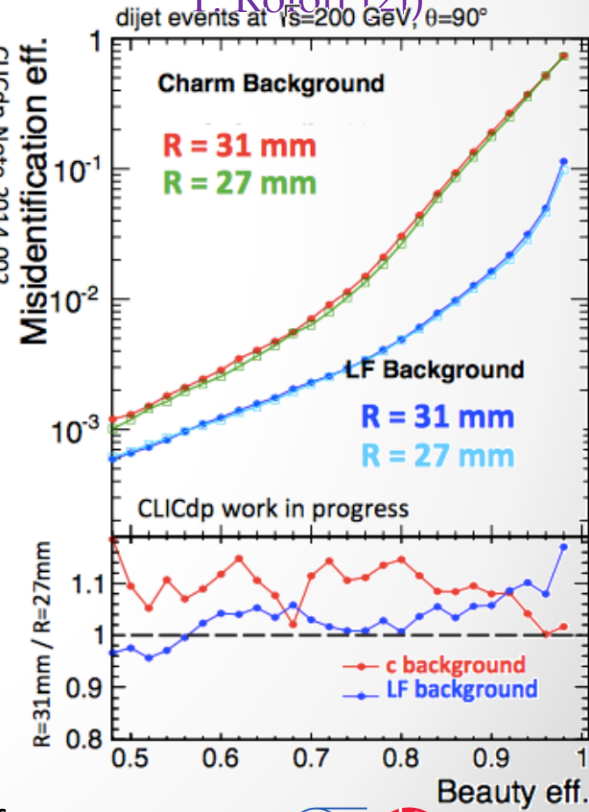
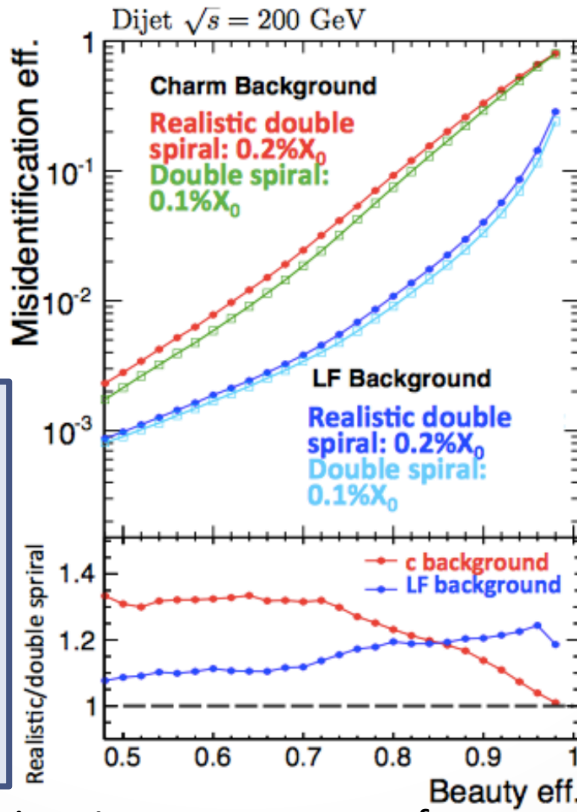
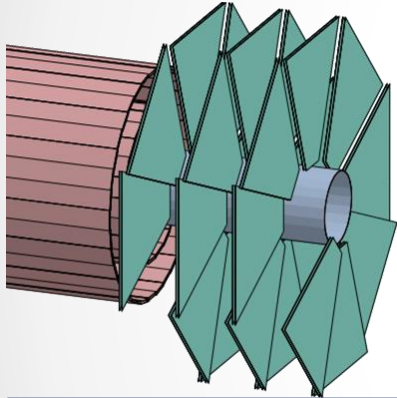


Vertex Detector Optimization

Use flavor tagging as a gauge in various tests :

1. Effect of material (most significant effect on performance)
2. Vary inner radius (dictated by background rates \leftrightarrow B-field)
3. Effect of spiral geometry (only small impact, better airflow)
4. Single vs. double layers (minor impact, benefits for support)

(N. Alipour
Tehrani,
P. Roloff [2])



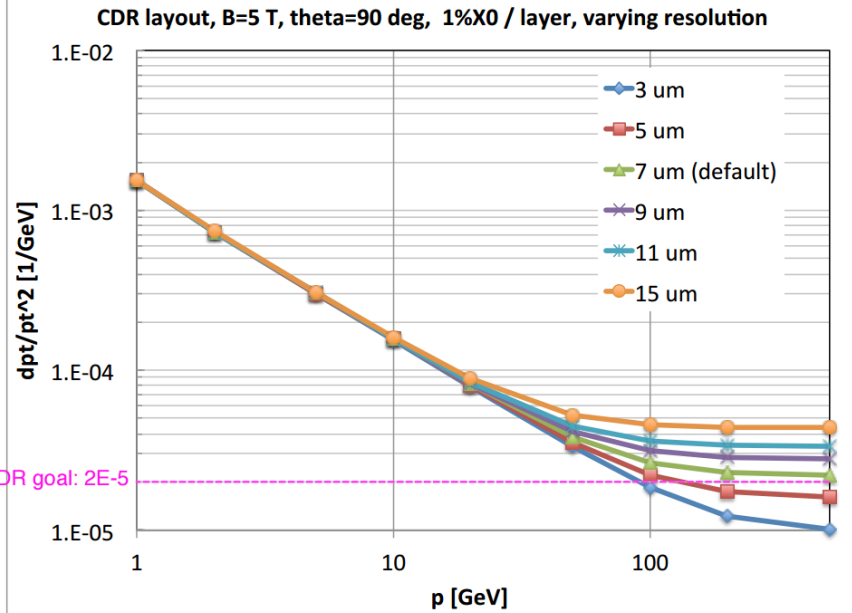
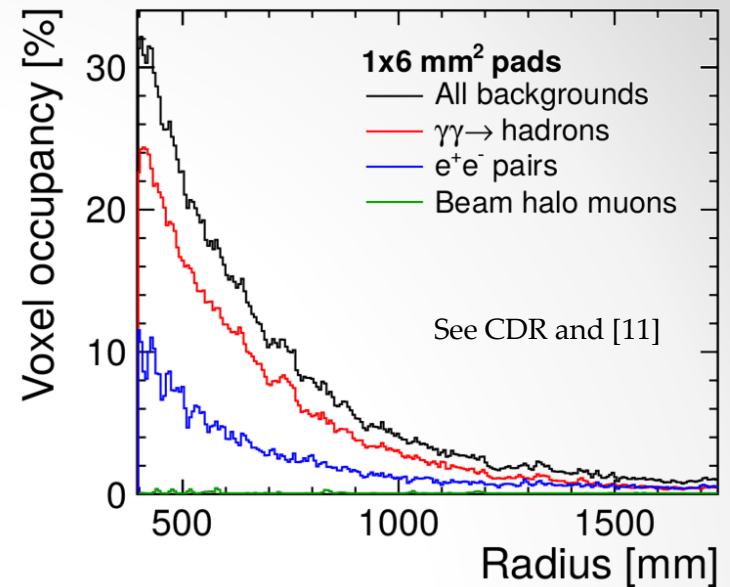
In the new detector model:

- Double layers with spirals
- $0.2\%X_0$ per (single) layer
- $R_{in} = 31$ mm
- Pixel size: $25 \mu\text{m}$
- $3 \mu\text{m}$ single point resolution

Ratio > 1 means worse performance for more material (left) or larger radius (right)

Silicon Tracker

- A TPC tracker would have very high occupancies (30%) for CLIC @ 3 TeV with $1 \times 6 \text{ mm}^2$ pads (without safety factors)
 - We use an All-Silicon Tracker for our new model

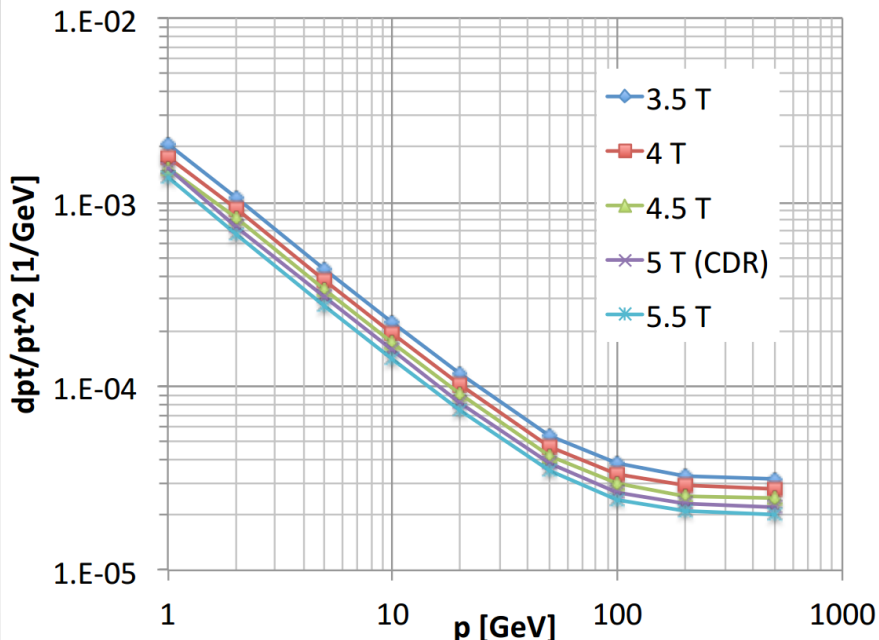


Fast simulation studies (LicToy) with CLIC_SID_CDR geometry (D. Dannheim et al. [3])

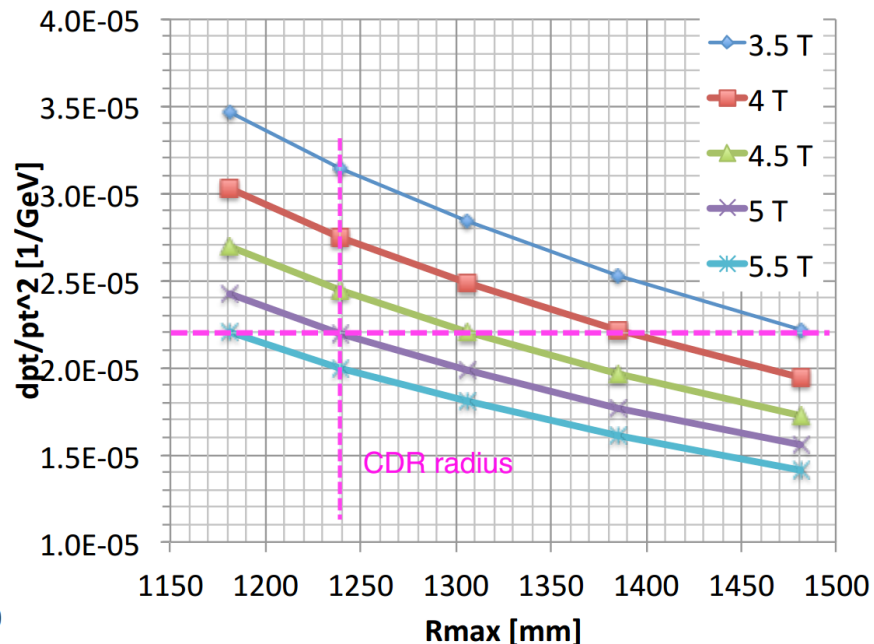
- Fast Simulation studies (LicToy) to determine optimal parameters
- Material Budget $\rightarrow \sim 1\%X_0$ per layer
 - Requires very thin materials/sensors
 - Less critical than in Vertex Detector
- Single point resolution: $\sim 7 \mu\text{m}$
 - Critical for high-momentum tracks

Silicon Tracker Radius/ B-field

CDR geometry, theta = 90 deg



varying outer radius, p=500 GeV, theta = 90 deg



- Tracking performance depends on tracker **radius** and **magnetic field**

$$\frac{\sigma(p_T)}{p_T^2} \propto \frac{\sigma^{meas}}{\sqrt{NB} \cdot R^2}$$

Stronger dependence on **R**

- Can compensate reduction of **B** in new detector by rescaling **R** by $\sqrt{B_{nom}/B}$
- Increase from **1.3 m (CLIC_SID)** but not much gain by going to 1.8 m (CLIC_ILD) -> **Converged to 1.5 m for new model**

More on Magnetic Field

- **B-Field and R affect Particle Flow Performance**

- Previous ILD studies by M. Thomson and J. S. Marshall [4,5]

- **Aiming for an outer tracking radius of 1.5 m**

- A magnetic field strength of up to 4.5 T should be technically feasible

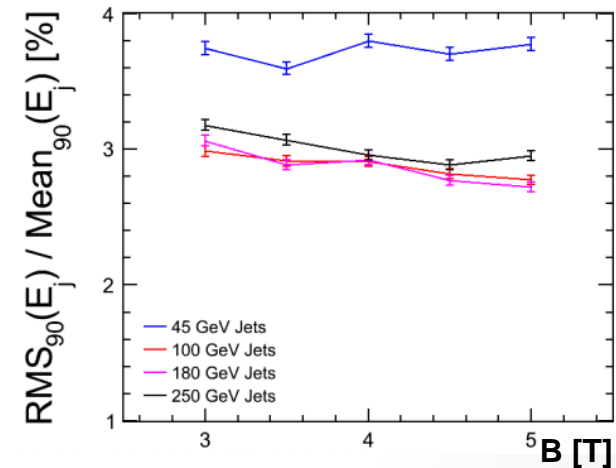
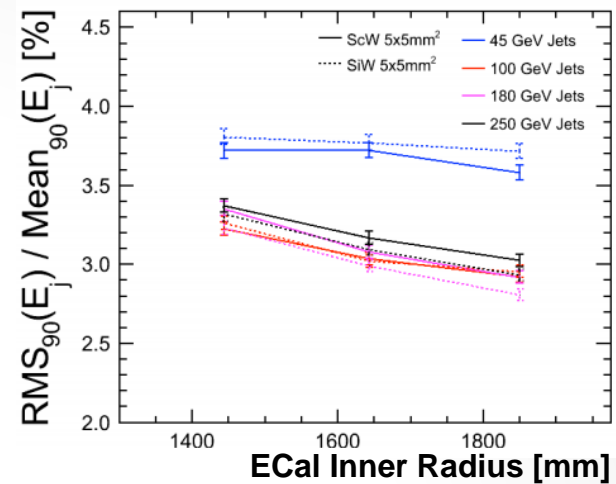
- **Use 4 T for next simulation model**

- **Effects of non-uniform magnetic field currently under investigation**

- Implementation of more realistic field map underway
- Changes in tracking software

- **Tracker length: at least ~CLIC_ILD (4.6 m)**

- **Motivated by physics in the forward region (e.g. Higgs self-coupling)**
- Reduce Endcap Yoke thickness by ~1.2 m and use End coils

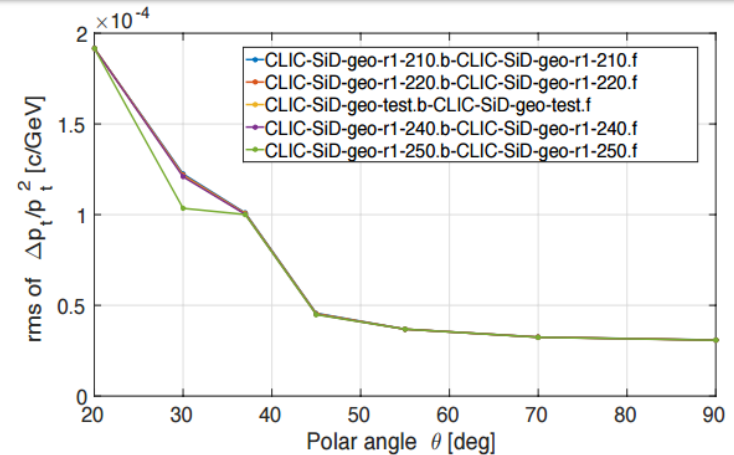
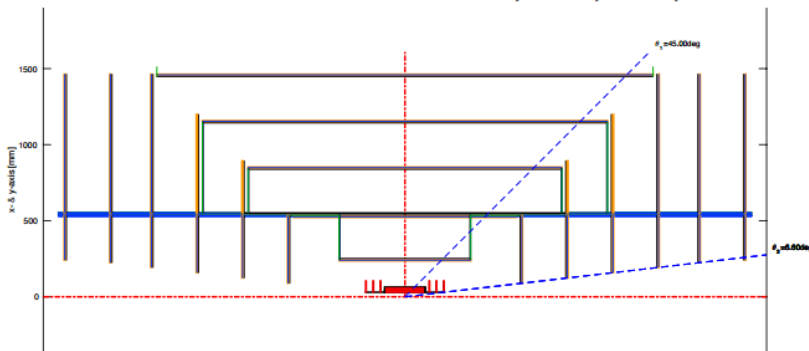


More Tracker Optimization (R. Simoniello[9])

- **Fast Simulation** (LicToy) Study varying **geometry and layout** (**R**, **length**, number of layers, etc) as well as **material** (supports, cabling, cooling)
 - Use p_T and d_0 resolution to gauge performance
- **Full simulation studies** also ongoing with new Reconstruction Software

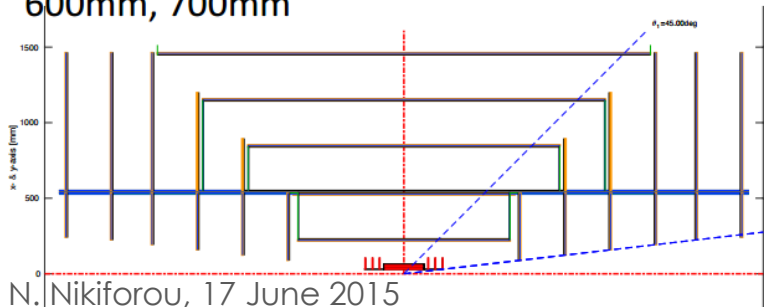
Move r position of the first barrel layer

Scan of r1 from 230mm to 210, 220, 240, 250mm



Change length of the first barrel layer

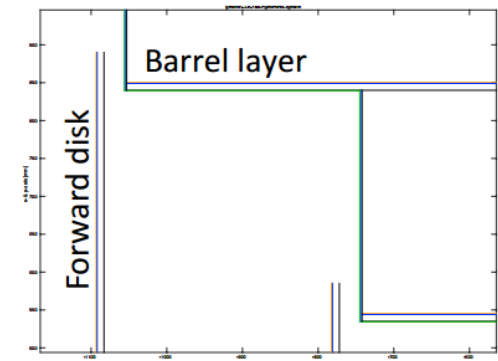
z1 varied from 430mm to 450mm, 500mm, 600mm, 700mm



N. Nikiforou, 17 June 2015

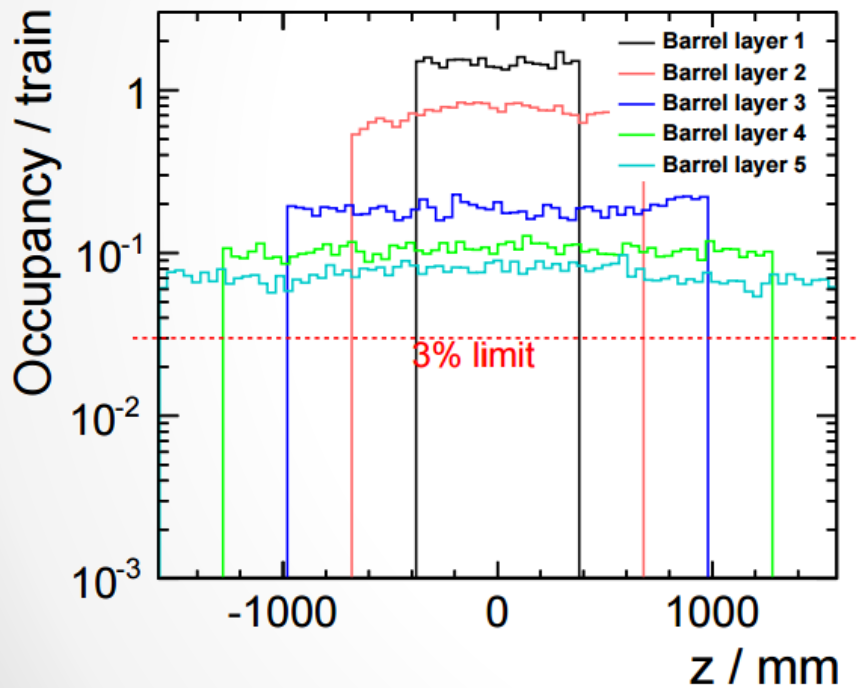
Optimise gap between barrel/forward and the outer radius of the forward disk

- $\Delta r = 40$ mm
- Gap = 30 mm
- Not full scan performed yet
- Gaps are not pointing to IP

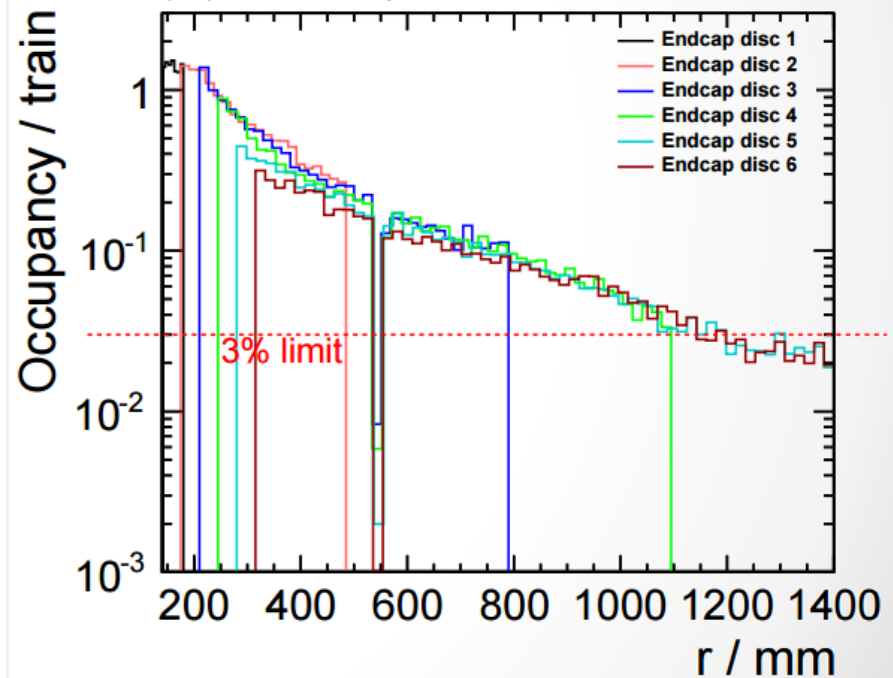


Occupancy in the main tracker

- High occupancies in certain regions
- Full Mokka-based (Geant4) simulation using a modified CLIC_ILD detector driver (TPC replaced with Si Layers)
- Assume $100 \text{ mm} \times 50 \text{ }\mu\text{m}$ strips, avg. cluster size 2.6 , **safety factors 5** (pairs) and 2 ($\gamma\gamma \rightarrow had$)



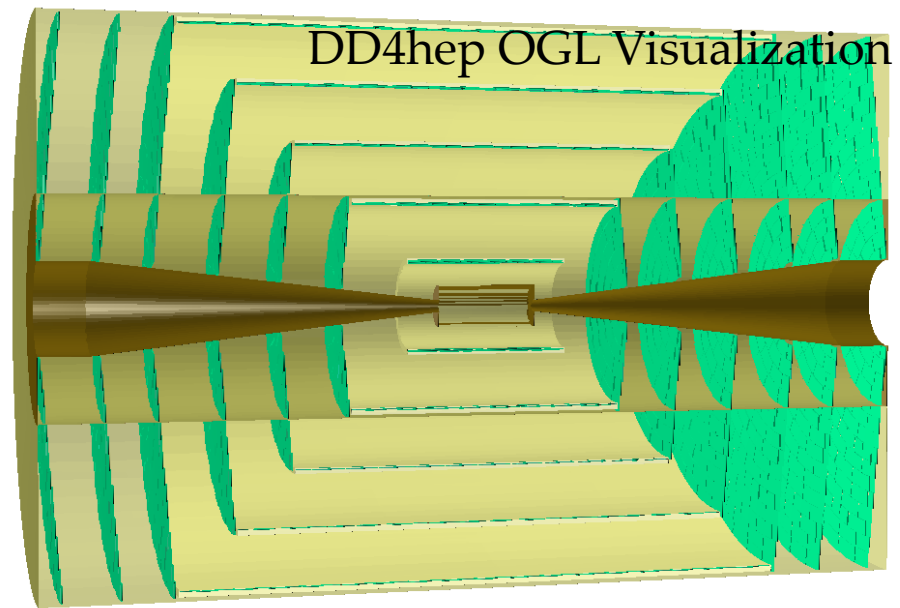
(Recent study by A. Nurnberg[10]. See also LCD-Note-2011-021[15])



- **Need for large pixels and/or short-strips**
- Maximal strip length to be below 3% limit depends on layer (2 – 50 mm in barrel)

Silicon Tracker: Recap

- *Optimization for an all-silicon tracker ongoing*
- 5 – 6 tracking layers with an ***Inner and Outer Tracker***
 - Support tube for extraction with beampipe assembly



- Power pulsing?
- Air cooling is probably not feasible in a large tracker volume
- Radiation level 10^4 times lower than LHC

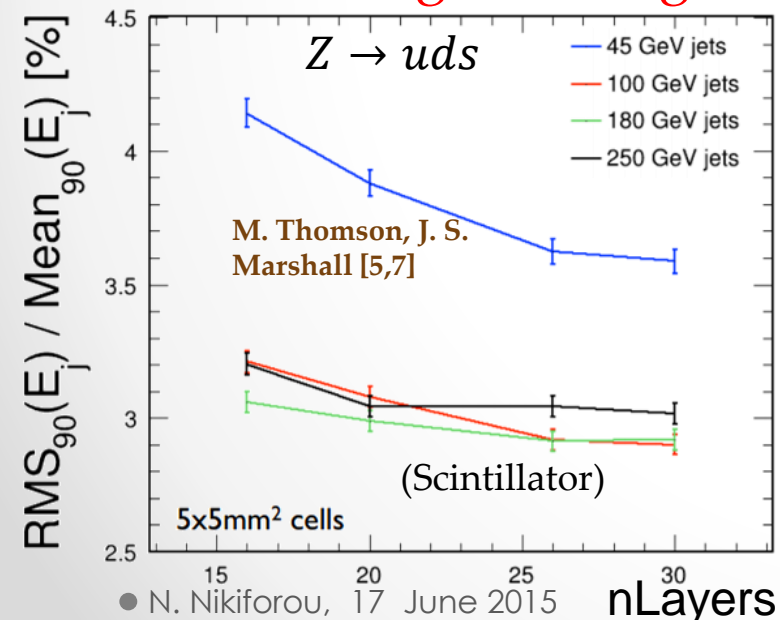
• *Now starting a tracker hardware R&D*

Calorimeter Optimization

- High granularity imaging calorimeters to use with **Pandora Particle Flow Algorithms**
- Variations on **Number and Layout of Layers, Cell size, absorber material and thickness, active material and thickness, total depth, ...**
- Optimization performed also in collaboration with ILD
 - Used mainly ILD-based Mokka drivers and ILD software chain
- **Need to recalibrate detector response with each variation**
 - Developed a quasi-automatic calibration procedure
- Gauge model performance using:
 - Single particle response
 - **Jet Energy Resolution** ($Z \rightarrow uds$, $WW \rightarrow v\ell ud$, $ZZ \rightarrow vvdd$)

ECal Optimization

- **Si vs Sc:** No significant effect on JER
- **# Layers:** Not very important for higher energy jets (PFA confusion dominates): **Not much more improvement from 25 to 30 layers**
- **Cell size:** Becomes important for higher energy jets (where PFA confusion dominates)
 - JER degradation from 3% to ~3.5% when increasing cell size from 5x5 mm² to 15x15 mm²
 - Combinations of different granularities in layers considered
 - **No significant gain for the extra complexity**



Working hypotheses for the simulation model:

- Silicon active material, Tungsten absorber
- 25 Layers, 23 X_0 / 1 λ_I
- Use 5x5 mm² cells throughout

HCal Optimization

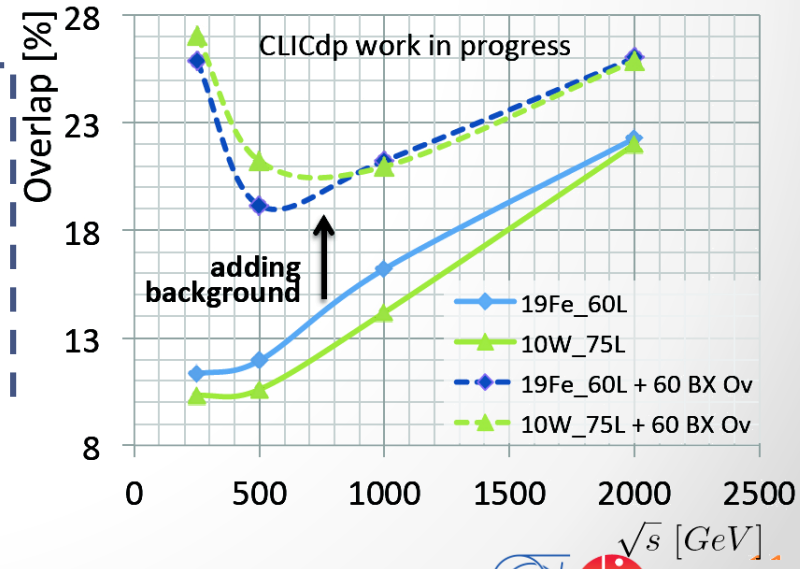
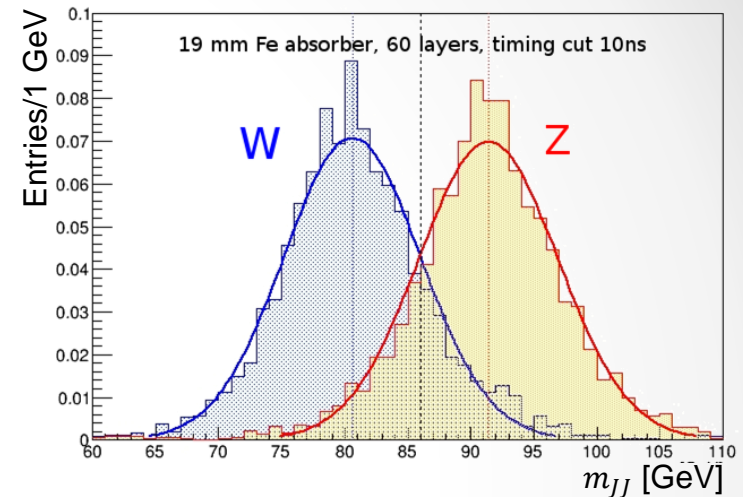
E.g. study overlap of m_W and m_Z measurement in $WW \rightarrow \nu\ell ud$ and $ZZ \rightarrow \nu\nu dd$ events

- Example: HCal Barrel Absorber
 - 10 mm Tungsten (W)
 - 19 mm Steel (Fe)

Keep same Depth at $\sim 7.5 \lambda_I$
- Full Geant4 detector simulation + PandoraPFA + FastJet
- Performance shown to be **similar** for tungsten and steel
- Steel is cheaper and easier to process

⇒ Use Steel as an absorber for the HCal

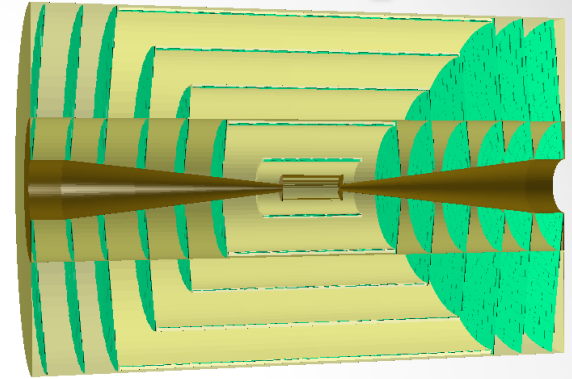
- 60 layers
- 20 mm Steel/3 mm Scintillator
- 30x30 mm² Cell size



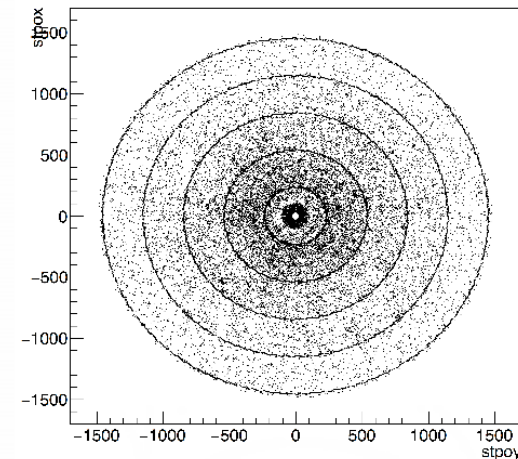
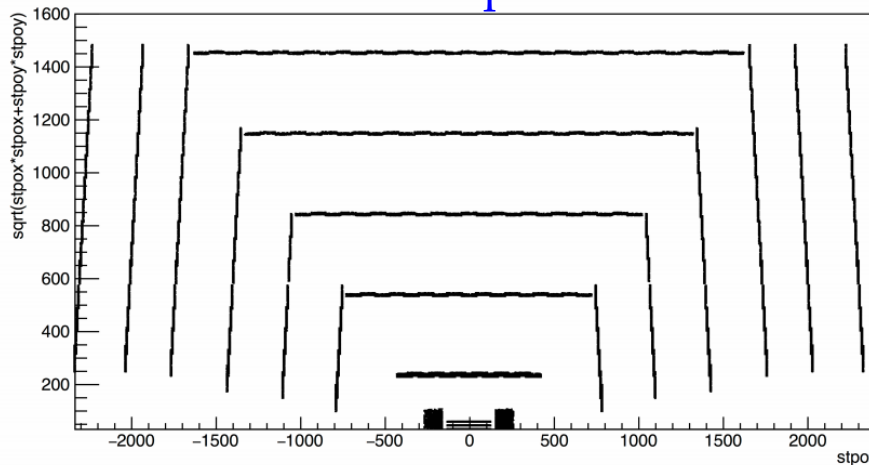
Implementation in SW

- Detector Implemented in DD4hep and in very good state
 - In package “lcgeo” with sharing/reuse of subdetector drivers with other experiments where possible
- Evolving, more detail being added continuously
 - Geometry driver development paradigm evolved from an SiD model (resized, adapted to CLIC_SiD) <- **DD4hep is Flexible!**
- **A Simulation and Reconstruction framework based on DD4hep and DDG4/DDRec is the way forward for us**
- **Working in collaboration with ILD to develop/validate reconstruction software based on DD4hep**
 - Tracking software
 - PandoraPFA

Vertex and Tracker in DD4hep

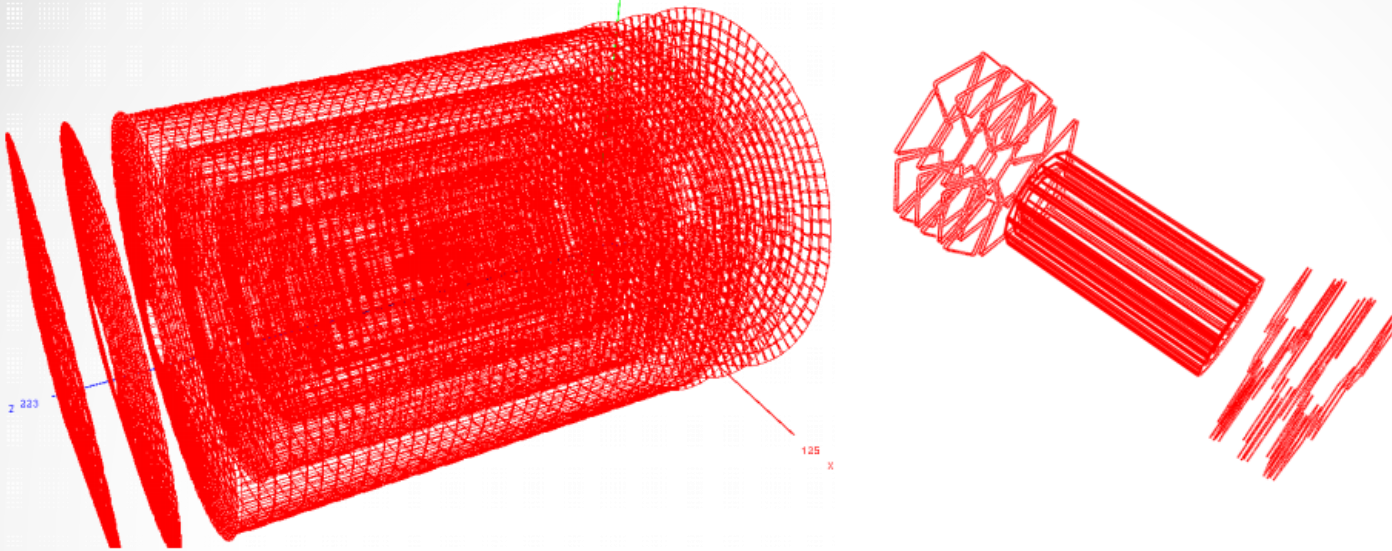


- Fairly resizable and scalable drivers implemented in DD4hep
 - Simpler drivers (e.g. no spirals) available as well
- Most important parameters (radii, layers, module layout,...) controlled by the “compact” xml
 - In principle not even need to recompile C++ driver!
- It works well too! Hit map from 100 $H\nu\nu$ events simulated with DDG4 below



Tracking in an All Si-Tracker

F. Gaede [13]
R. Simoniello [9]

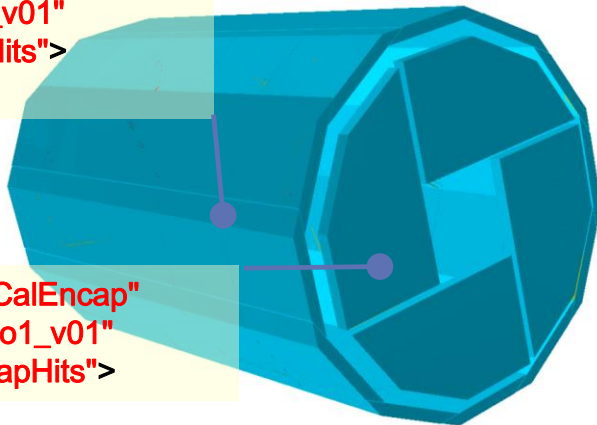


The (>19000)
tracking surfaces
in the CLIC
model

- **Based on DD4hep/DDRec**
- **Track Fitting Strategy:**
 - Fit inside-out starting with vertex pixel hits
 - 1D hits in main tracker (strips) provide no constraint in z so cannot be used to initialize tracks
 - Finally smooth back to third hit and fit inside from there
- Current pattern recognition being developed from ILD Celloular Automaton-based Vertex patt. Rec.

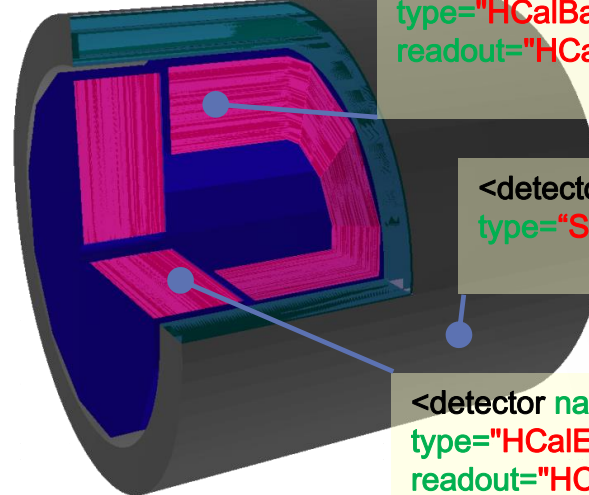
Calorimeters

```
<detector name="ECalBarrel"
type="ECalBarrel_o1_v01"
readout="ECalBarrelHits">
```



```
<detector name="ECalEncap"
type="ECalEndcap_o1_v01"
readout="ECalEndcapHits">
```

```
<detector name="HCalBarrel"
type="HCalBarrel_o1_v01"
readout="HCalBarrelHits">
```



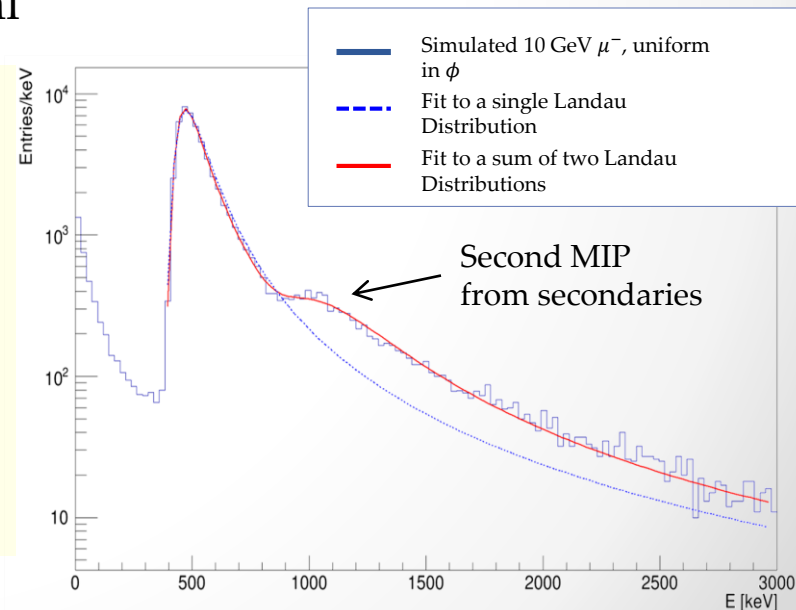
```
<detector name="Solenoid"
type="Solenoid_o1_v01">
```

```
<detector name="HCalEncap"
type="HCalEndcap_o1_v01"
readout="HCalEndcapHits">
```

- Fairly scalable drivers
- Radii, Layer/module composition in compact xml

```
<detector ...>
...
<dimensions numsides="HCal_symmetry" rmin="HCal_inner_R" z="HCal_half_L*2" />
<layer repeat="(int) HCal_layers" >
<slice material="Steel235" thickness="0.5*mm"/>
<slice material="Steel235" thickness="19*mm"/>
<slice material="Polystyrene" thickness="3*mm" sensitive="yes"/>
<slice material="PCB" thickness="0.7*mm"/>
<slice material="Steel235" thickness="0.5*mm"/>
<slice material="Air" thickness="2.7*mm"/>
</layer>
</detector>
```

- Simulation and reconstruction under validation



Conclusions

- New simulation model for a detector at CLIC evolving from previous CDR models based on modified ILD designs
- Optimization result of a big effort from many people and still ongoing
- **Important R&D efforts also ongoing (not covered today)**
- New detector model implemented and being refined in DD4hep with relative **flexibility/scalability**
- Users of ILCSoft and the ILD software chain
- Developing **simulation** and **reconstruction** software based on **DD4hep** in collaboration with ILD
- Some references available on next slide

References

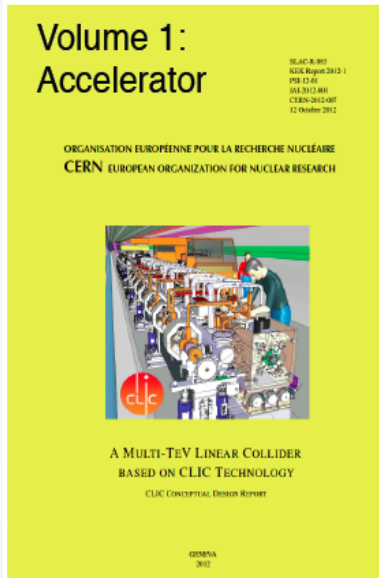
1. L. Linssen et al., **Physics and Detectors at CLIC : CLIC Conceptual Design Report**, [CERN-2012-003](#)
2. N. Alipour Tehrani and P. Roloff, **Optimisation Studies for the CLIC Vertex-Detector Geometry**, [CLICdp-Note-2014-002](#)
3. D. Dannheim et al., Slides at <https://indico.cern.ch/event/309925/contribution/2/material/slides/0.pdf>
4. M. Thomson, *Nucl.Instrum.Meth. A611 (2009)*
5. J. Marshall, Slides at <http://indico.cern.ch/event/309926/contribution/1/material/slides/0.pdf>
6. B. Cure, Slides at <https://indico.cern.ch/event/314325/contribution/1/material/slides/1.pdf>
7. M. Thomson, Slides at <http://indico.cern.ch/event/309926/contribution/1/material/slides/0.pdf>
8. M. Valentan et al, [LiC Detector Toy Fast Simulation](#)
9. R. Simoniello, Slides at <https://indico.cern.ch/event/376800/session/3/contribution/5/material/slides/0.pdf>
10. A. Nurnberg, Slides at <https://indico.cern.ch/event/376800/session/2/contribution/28/material/slides/0.pdf>
11. M. Killenberg, [LCD-Note-2011-029](#)
12. J. S. Marshall, Slides at <https://indico.cern.ch/event/336335/session/6/contribution/5/material/slides/0.pdf>
13. F. Gaede, Slides at <https://indico.cern.ch/event/376800/session/0/contribution/12/material/slides/0.pdf>
14. M. Petric, Slides at <https://indico.cern.ch/event/376800/session/0/contribution/11/material/slides/0.pdf>
15. D. Dannheim, A. Sailer, Beam-Induced Backgrounds in the CLIC detectors, [LCD-Note-2011-021](#)
16. E. van Der Kraaij, Detector challenges at CLIC, contrasted with the LHC case, slides at <http://indico.cern.ch/event/210720/>

Backup Material

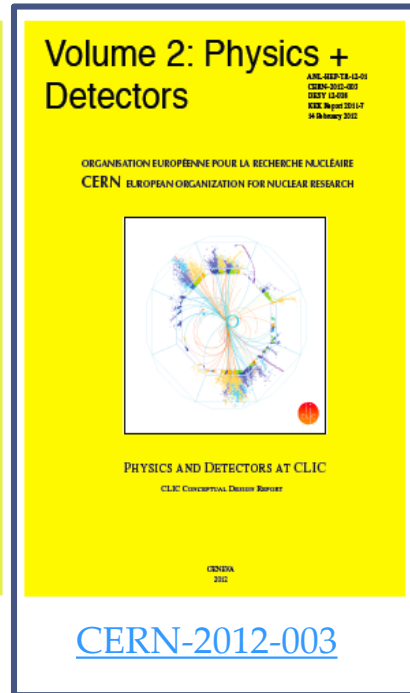
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CLIC and Detector Documentation

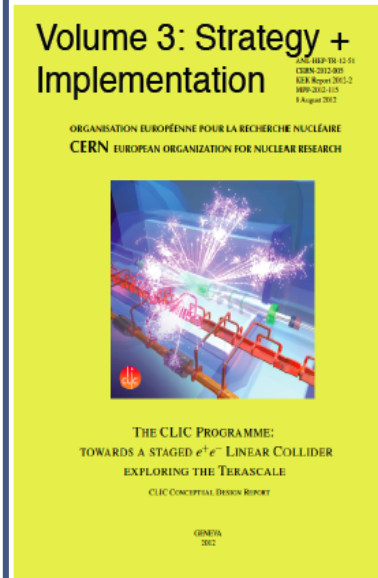
- 2012: **CLIC Conceptual Design Report** published
- 2012: CLIC detector and physics collaboration (**CLICdp**) was set up
- 2012/2013: CLIC input to the European strategy and the Snowmass Process in the US



[CERN-2012-007](https://cds.cern.ch/record/1307528/files/CERN-2012-007.pdf)



[CERN-2012-003](https://cds.cern.ch/record/1307528/files/CERN-2012-003.pdf)



[CERN-2012-005](https://cds.cern.ch/record/1307528/files/CERN-2012-005.pdf)



[arXiv:1307.5288](https://arxiv.org/abs/1307.5288)

More on Beam-Beam Effects

Beamstrahlung can cause important energy losses right at the interaction point

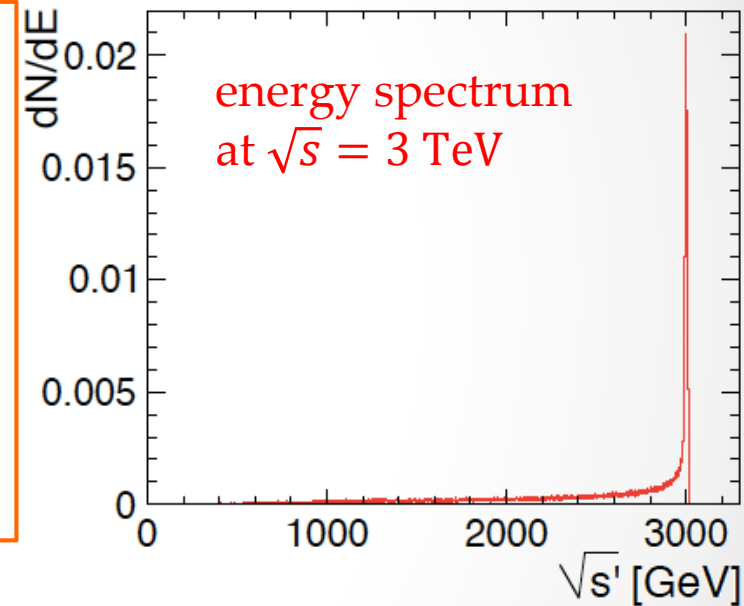
E.g. full luminosity at 3 TeV:

$$5.9 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$$

Of which in the 1% most energetic part:

$$2.0 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$$

Most physics processes are studied well above production threshold => profit from full luminosity



CLIC power and energy

Table 5.1: Nominal power and efficiency for staging scenarios A and B, where $W_{main\ beam}$ is for the two main beams.

Staging scenario	\sqrt{s} (TeV)	$\mathcal{L}_{1\%}$ ($\text{cm}^{-2}\text{s}^{-1}$)	$W_{main\ beam}$ (MW)	$P_{electric}$ (MW)	Efficiency (%)
A	0.5	$1.4 \cdot 10^{34}$	9.6	272	3.6
	1.4	$1.3 \cdot 10^{34}$	12.9	364	3.6
	3.0	$2.0 \cdot 10^{34}$	27.7	589	4.7
B	0.5	$7.0 \cdot 10^{33}$	4.6	235	2.0
	1.5	$1.4 \cdot 10^{34}$	13.9	364	3.8
	3.0	$2.0 \cdot 10^{34}$	27.7	589	4.7

Table 5.2: Residual power without beams for staging scenarios A and B.

Staging scenario	\sqrt{s} (TeV)	$P_{waiting\ for\ beam}$ (MW)	$P_{shut\ down}$ (MW)
A	0.5	168	37
	1.4	190	42
	3.0	268	58
B	0.5	167	35
	1.5	190	42
	3.0	268	58

CLIC_ILD and CLIC_SiD

For the CLIC CDR (2012):

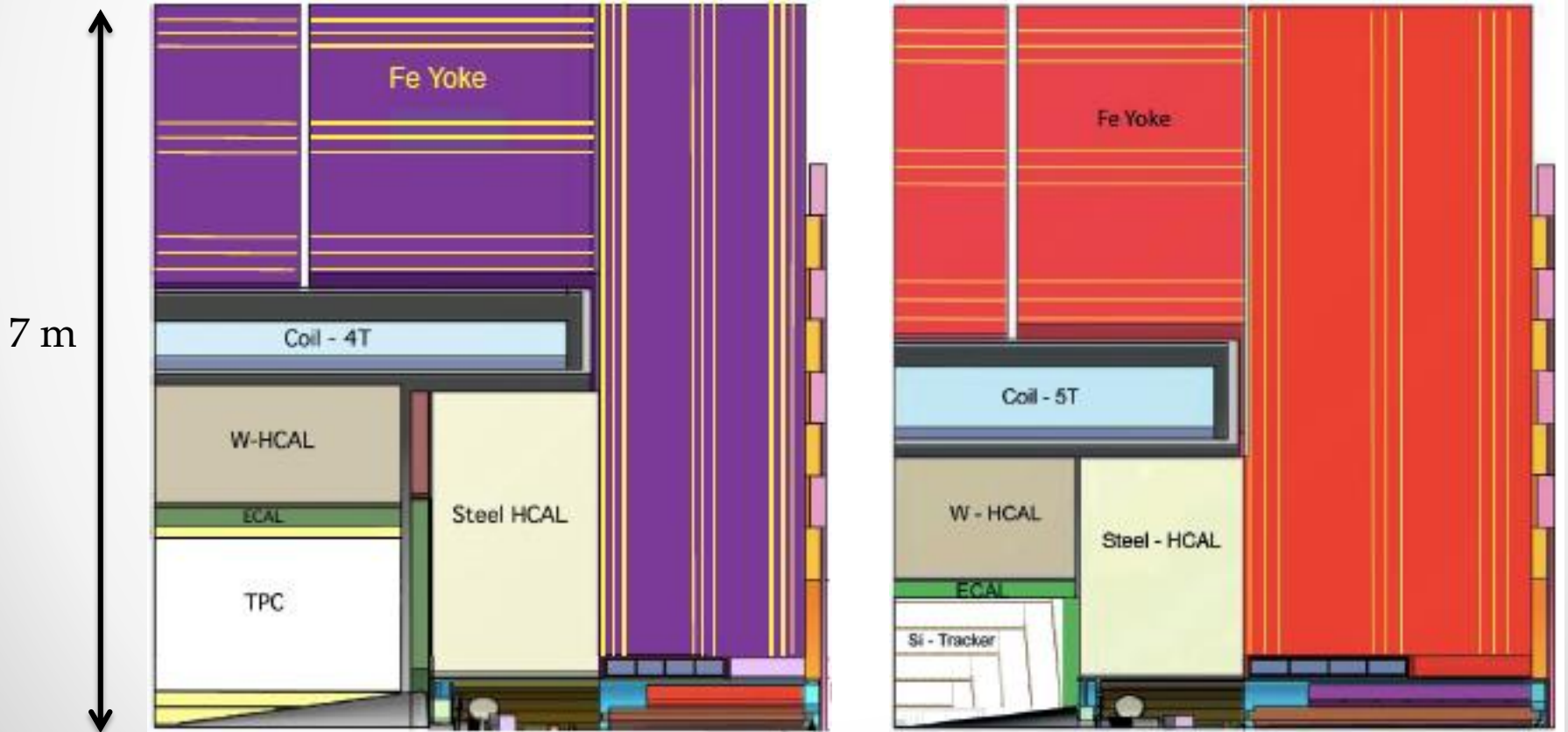
Two general-purpose CLIC detector concepts

Based on initial ILC concepts (ILD and SiD)

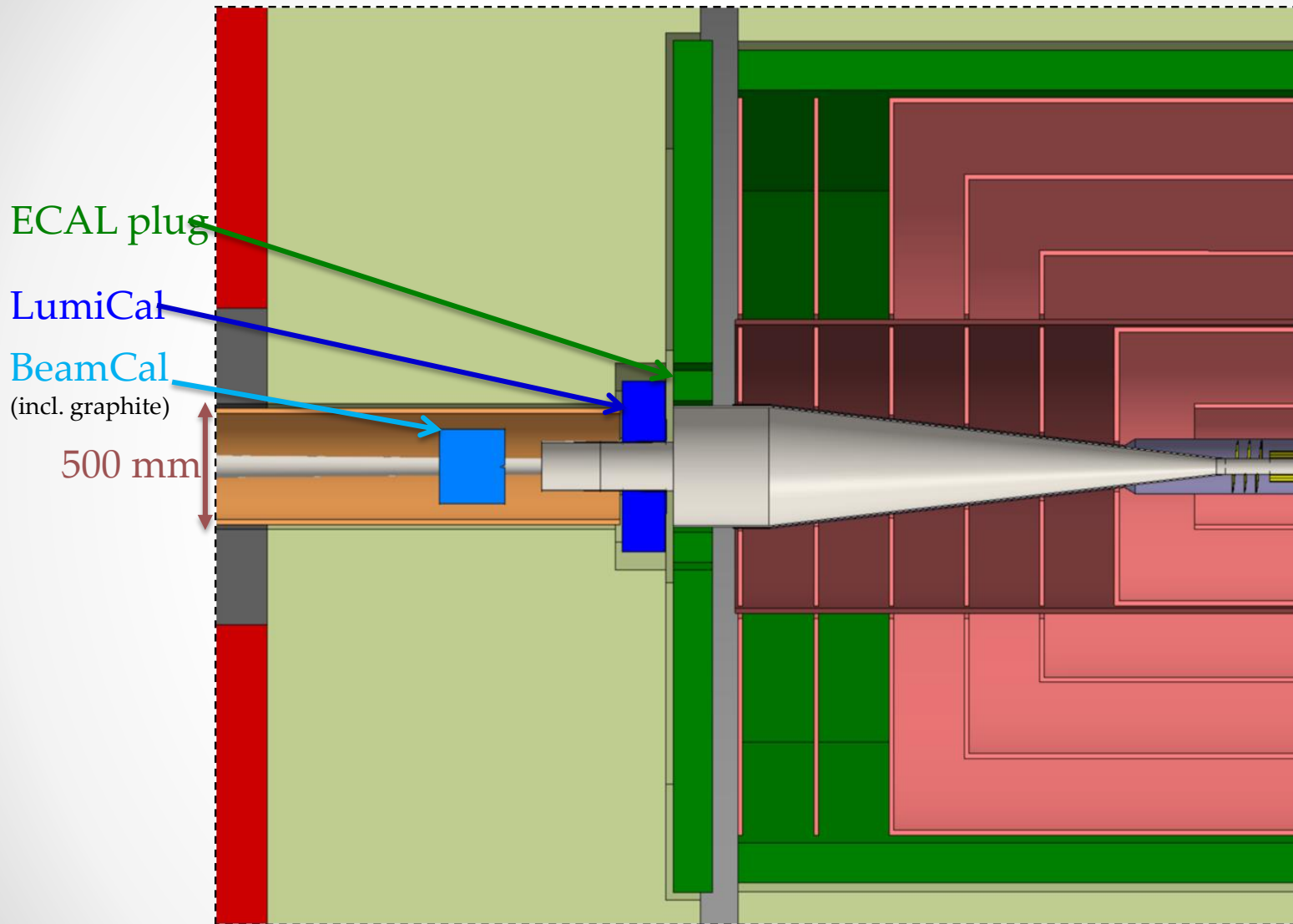
Optimised and adapted to CLIC conditions

CLIC_ILD

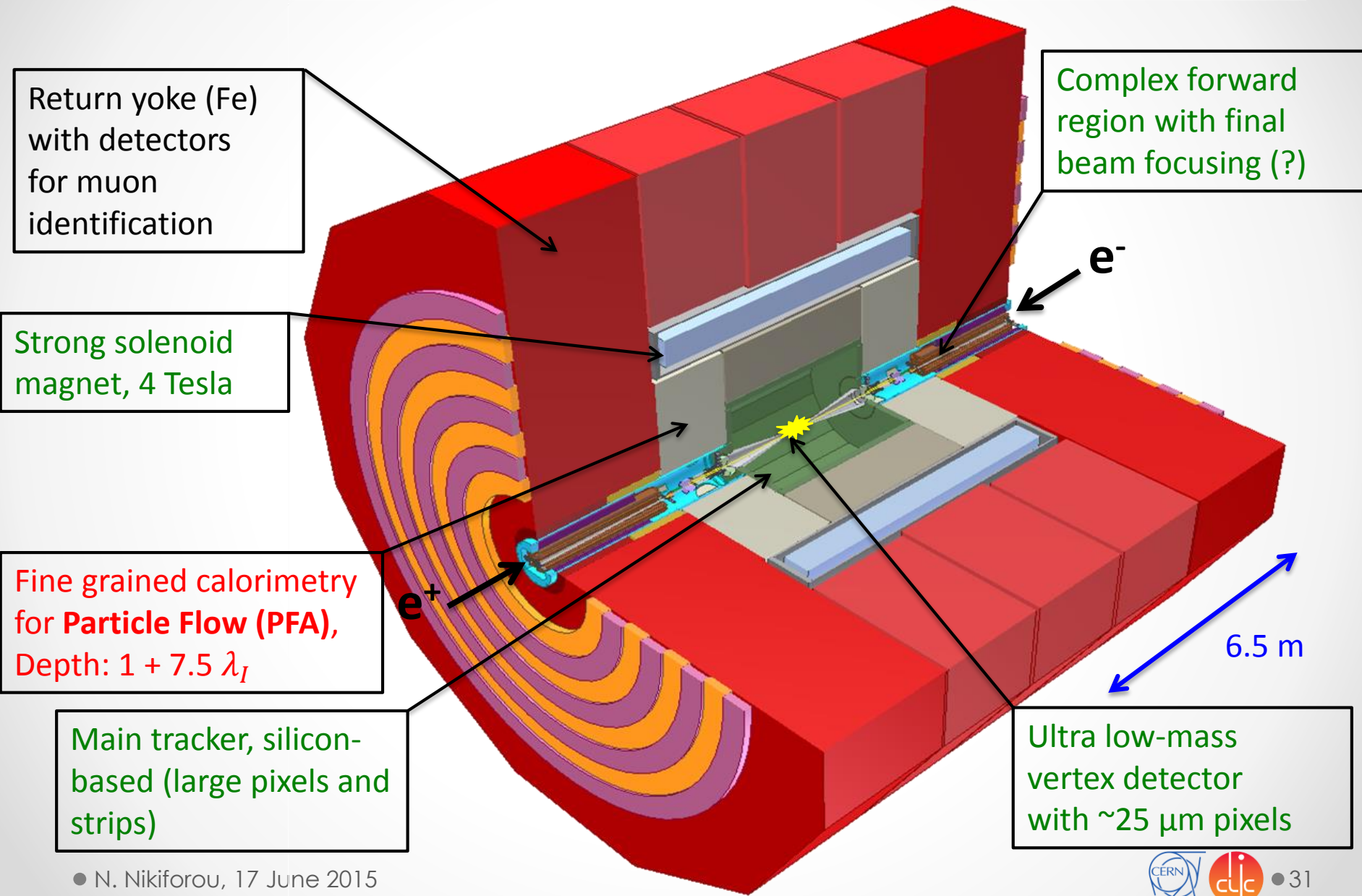
CLIC_SiD



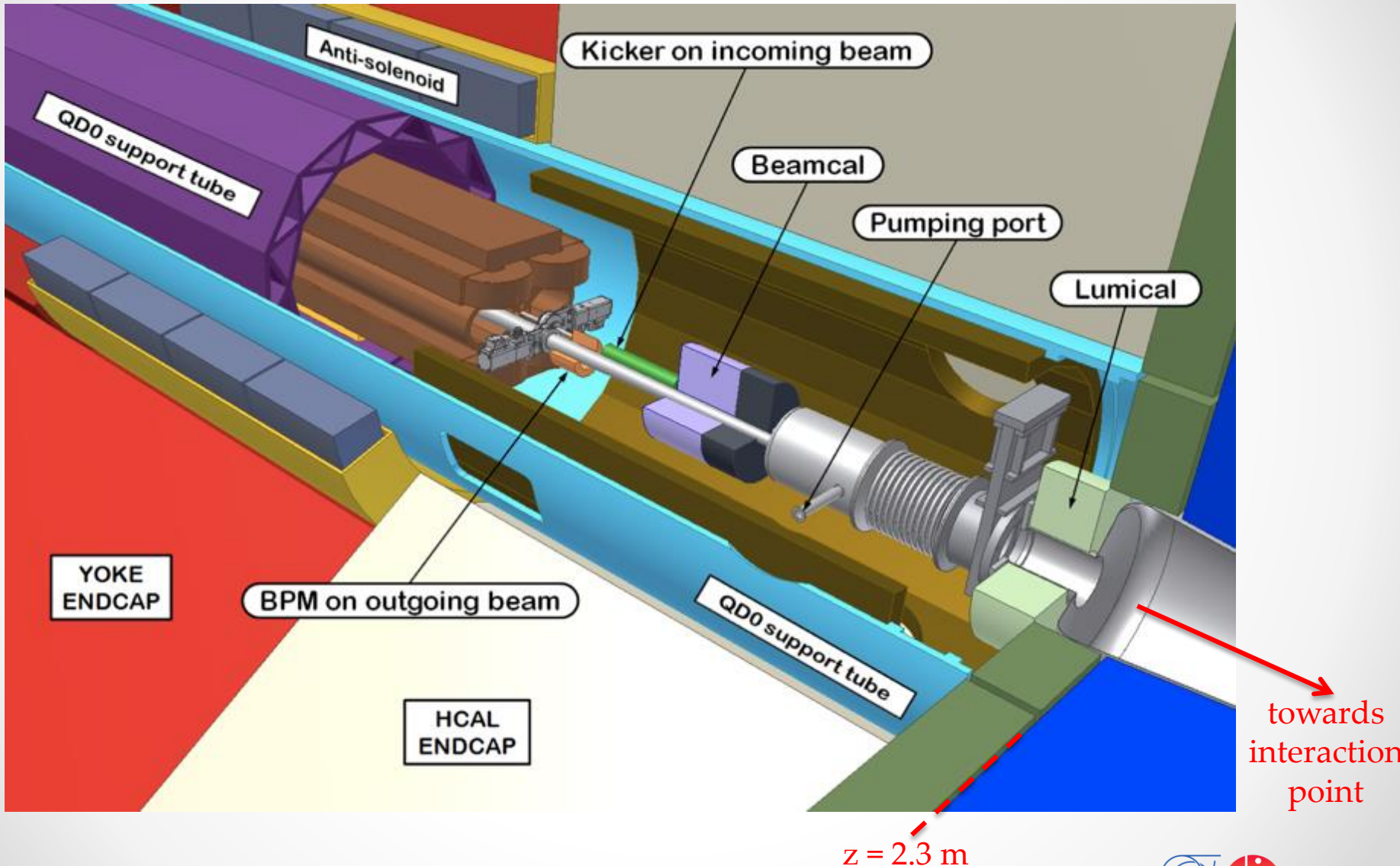
Forward Region Layout in the New Model



Basic Outline of a Detector at CLIC



(Older) Forward region layout



Comparison CLIC/LHC Detector

In a nutshell:

CLIC detector:

•High precision:

- Jet energy resolution
 - => fine-grained calorimetry
- Momentum resolution
- Impact parameter resolution

•Overlapping beam-induced background:

- High background rates, medium energies
- High occupancies
- Cannot use vertex separation
- Need very precise timing (1ns, 10ns)

•“No” issue of radiation damage (10^{-4} LHC)

- Except small forward calorimeters

•Beam crossings “sporadic”

•No trigger, read-out of full 156 ns train

LHC detector:

•Medium-high precision:

- Very precise ECAL (CMS)
- Very precise muon tracking (ATLAS)

•Overlapping minimum-bias events:

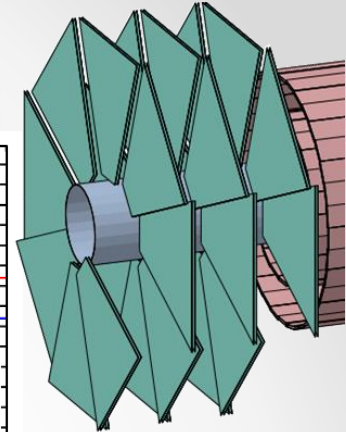
- High background rates, high energies
- High occupancies
- Can use vertex separation in z
- Need precise time-stamping (25 ns)

•Severe challenge of radiation damage

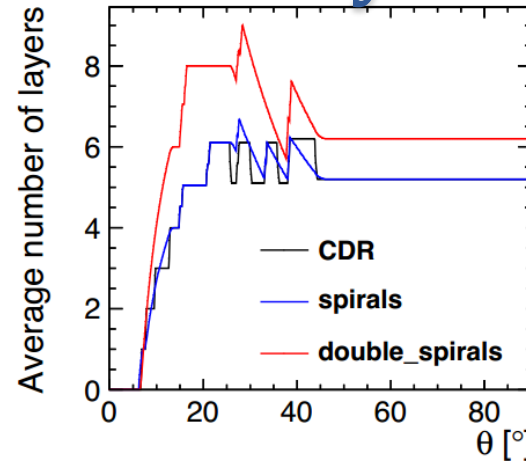
•Continuous beam crossings

•Trigger has to achieve huge data reduction

Vertex Detector: double layers

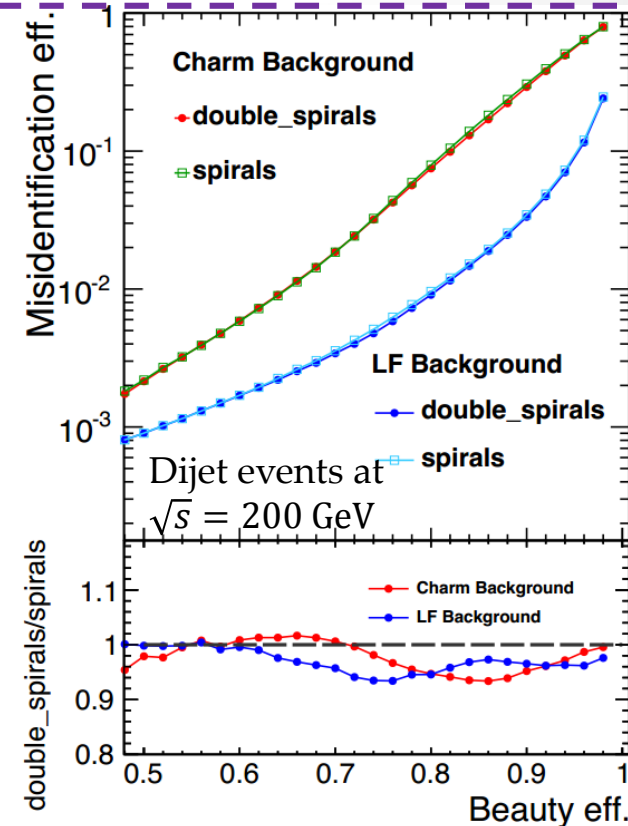


34

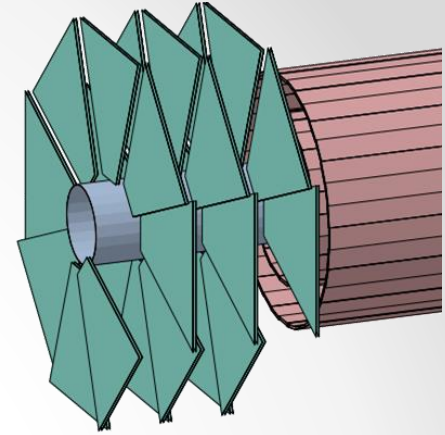


- 0.18% X_0 per double-layer in simulation
- Spiral Geometry (better airflow)
- Barrel: 5 single-layers \Rightarrow 3 double-layers
- Endcap: 4 single-layers \Rightarrow 3 double-layers

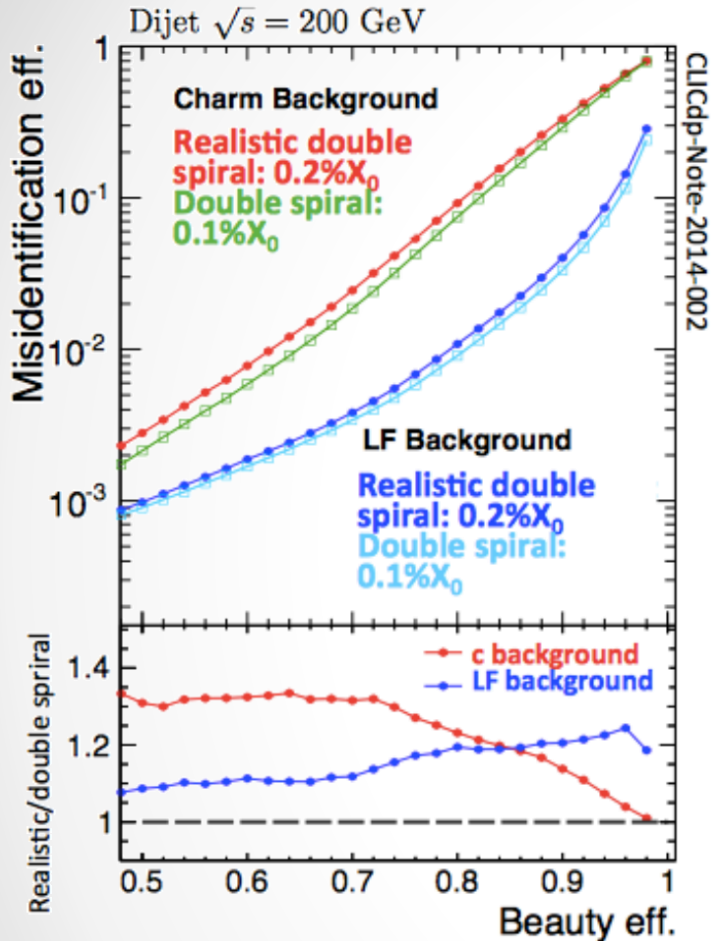
- Estimate changes in performance due to layout by studying the **flavor-tagging performance** (N. Alipour Tehrani, P. Roloff [2])
- b -quark misidentification as a function of b -quark Identification efficiency with a background rich in c -quarks (Top lines) or Light-Flavored quarks (bottom lines). Similar study performed for c -tagging
- Lower panel shows ratio of double-layer over the single-layer geometries
 - **Almost the same as single-layer layout**



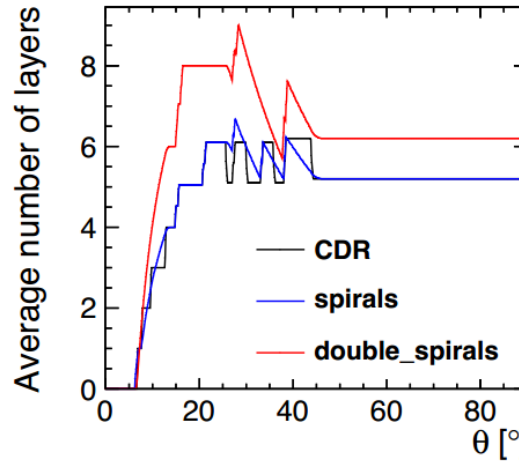
Vertex Detector Optimization



Spiral Geometry
(better airflow)



Effect of extra material:
 Ratio > 1 means worse performance for more material

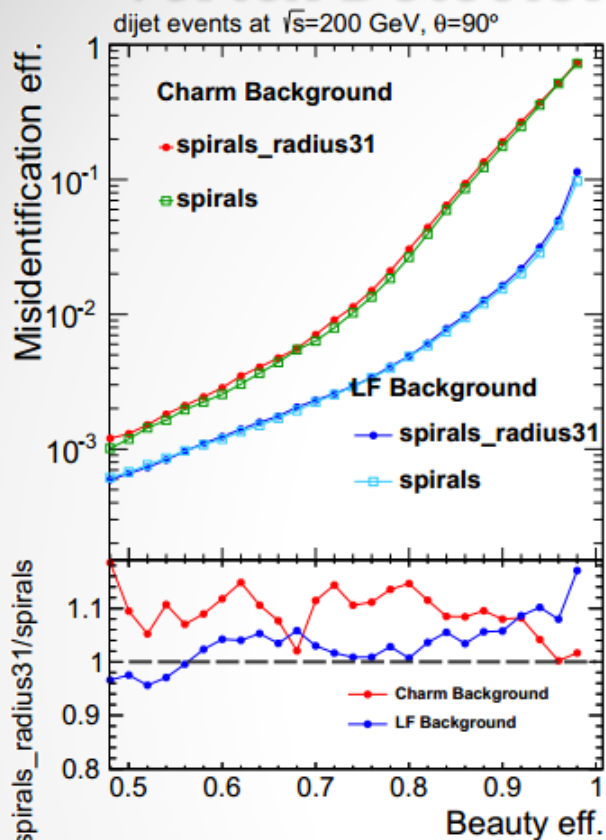


Use flavor tagging as a gauge in various tests:

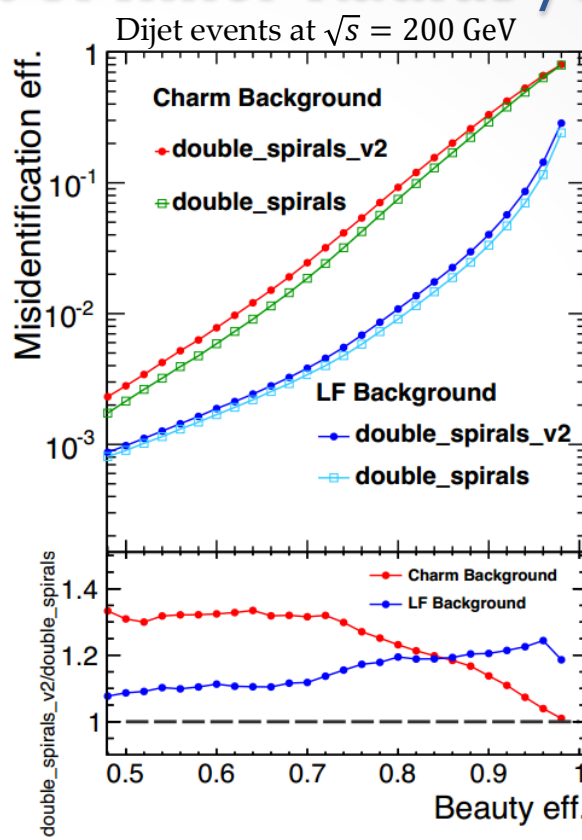
1. Effect of material (most significant effect on performance)
2. Test single vs. double layers
3. Vary inner radius (for 4 T or 5 T B-field)

In the new detector model: Use double layers with spirals and modules with $0.2\%X_0$ per (single) layer, $R_{in} = 31$ mm

Vertex Detector : Effect of Inner Radius /Material

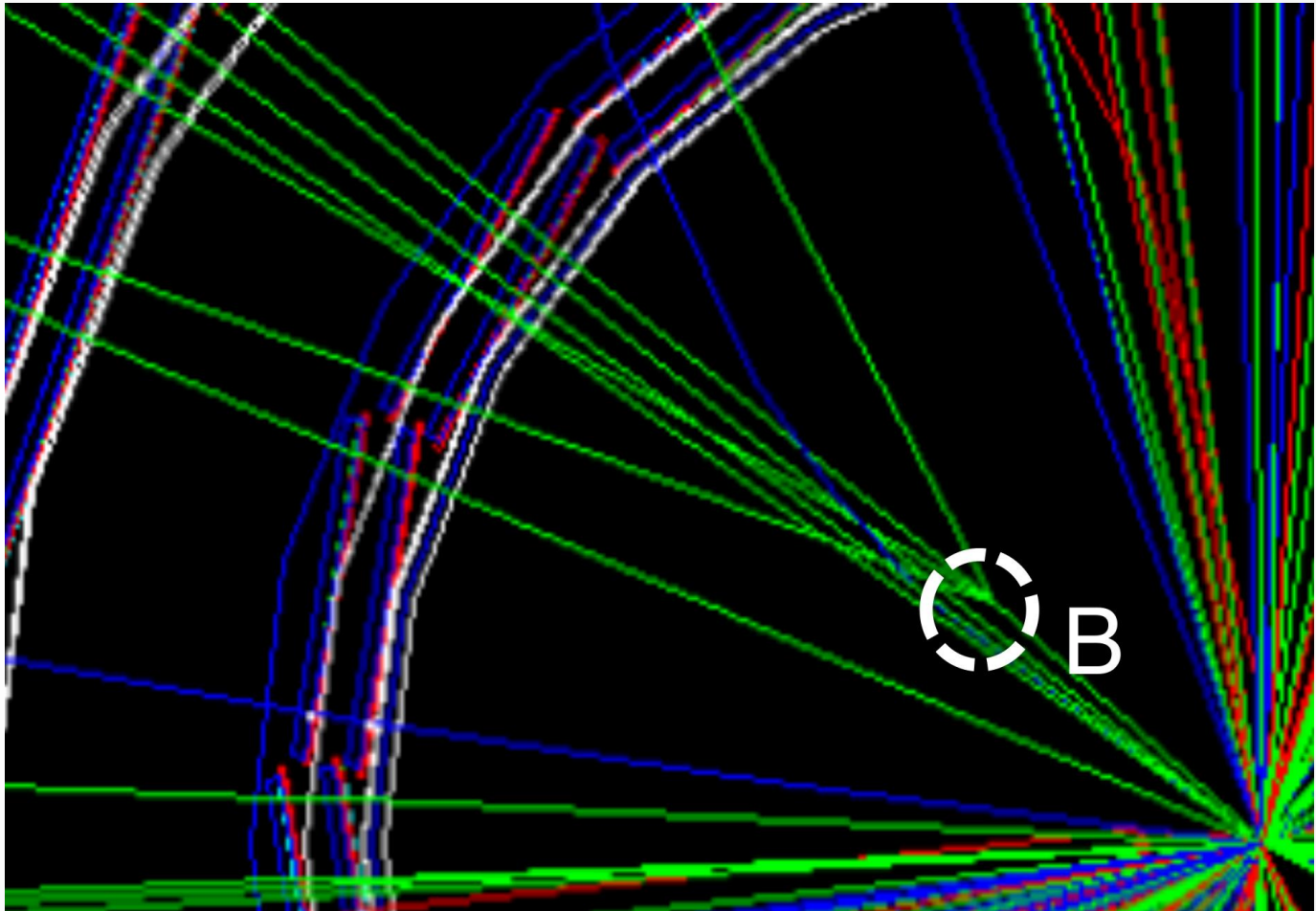


(N.Alipour Tehrani, P. Roloff [2])



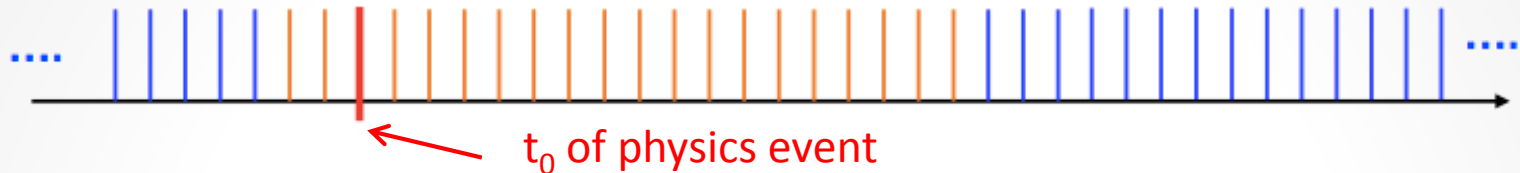
- Inner Radius from 27 mm to 31 mm
- Compensates for increase in the rate of Incoherent e-pair background if B-field is reduced
- Small effect in flavor-tagging performance
- Double-layer modules were simulated with twice as much material
- Extra material leads to undesirable increase of fake rate

In the new detector model: Use double layers with spirals and modules with $0.2\%X_0$ per (single) layer

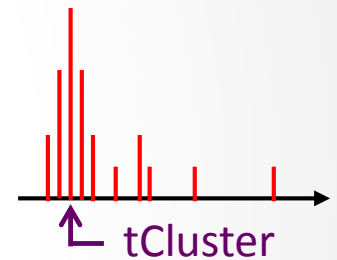


Background Suppression

Triggerless readout of entire train:



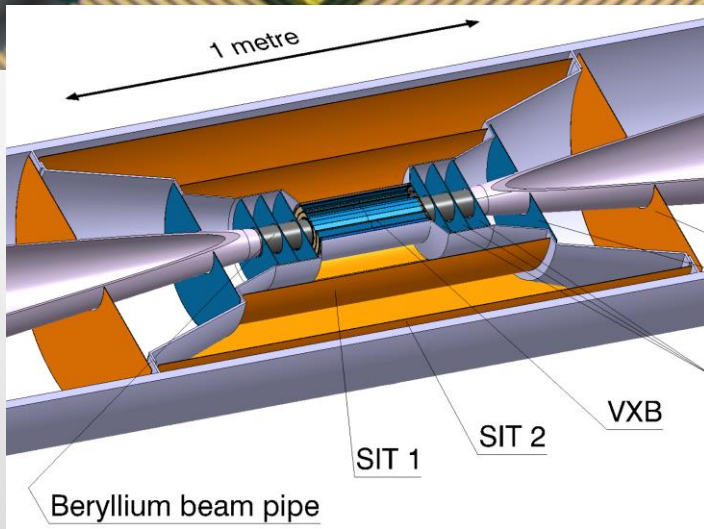
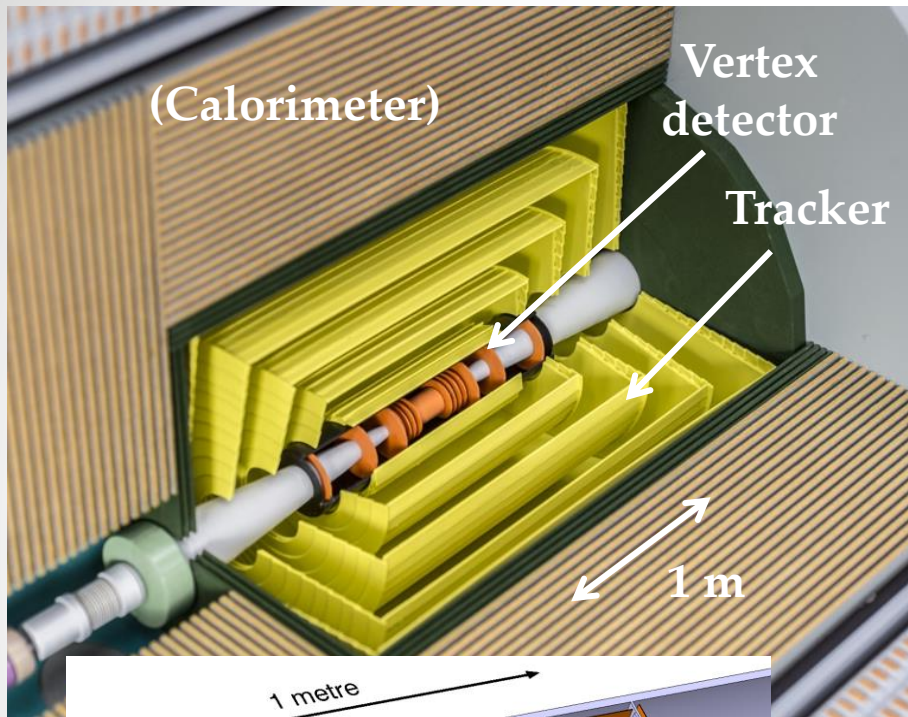
- Identify t_0 of physics event offline
 - Correct for shower development and TOF, define reconstruction window around t_0
 - Pass all calorimeter hits and tracks within window to reconstruction
 - Obtain physics objects with precise p_T and cluster time information
- Then apply cluster-based timing cuts
 - Cuts depend on particle type, p_T and detector region
 - Protects high- p_T physics objects
- **Also:** use hadron collider-type jet algorithms (*FastJet*)



General Requirements on Detector Technologies

- **CLIC conditions** \Rightarrow **impact on detector technologies**:
 - **High tracker occupancies** \Rightarrow **need small cell sizes** (beyond what is needed for resolution)
 - Small vertex pixels
 - Large pixels / short strips in the tracker
 - **Background suppression**
 - Need **high-granularity calorimetry**
 - **1 ns** accuracy for calorimeter hits
 - **~ 10 ns** hit time-stamping in tracking
 - **Low duty cycle**
 - Triggerless readout
 - Allows for **power pulsing**
 - less mass and high precision in tracking
 - high density for calorimetry

Vertex Detector (pixels)



Flavor tagging capabilities drive the design of the vertex detector

has to be extremely accurate and light !

- 2 billion pixels
- 3 μm single point resolution
- 25x25 μm^2 pixels (25 times smaller pixel area than LHC)
 - Pulse height measurement
 - Time measurement to 10 ns
- Ultra-light \Rightarrow 0.2% X_0 per layer
 - Very thin materials/sensors
 - Low-power design, power pulsing, air cooling
 - Aim: 50 mW/cm²
 - Radiation level 10^4 lower than LHC

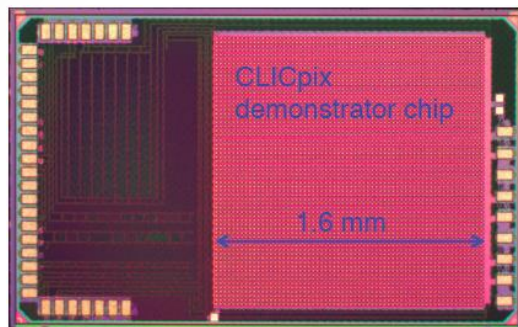
high-tech R&D
covering several
disciplines

Vertex Detector R&D

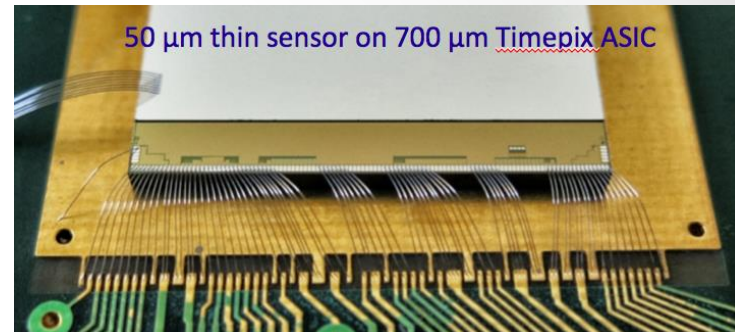
thin silicon sensor



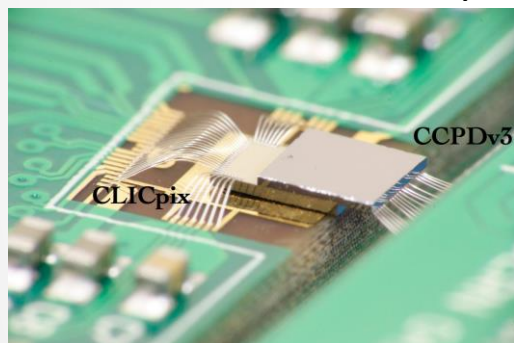
electronics chip (65 nm)



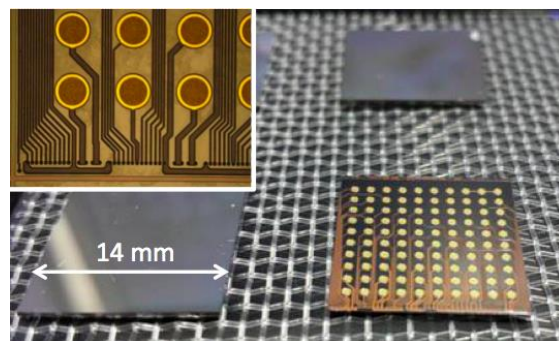
thin electronics + sensor assembly



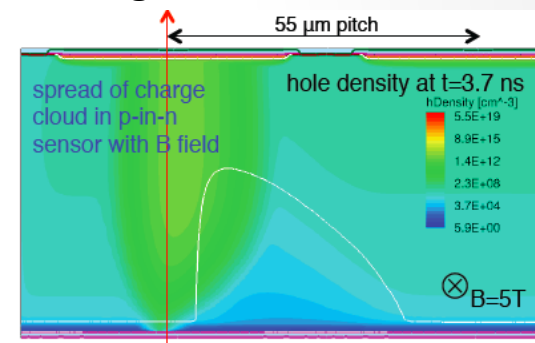
HV-CMOS sensor + CLICpix



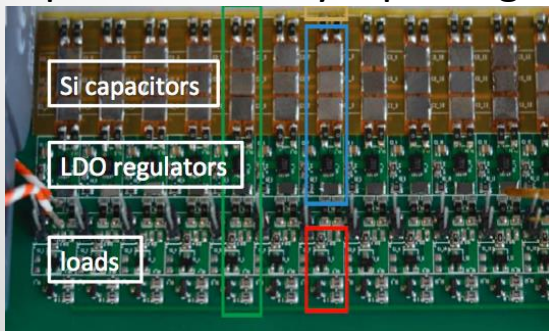
interconnect technology



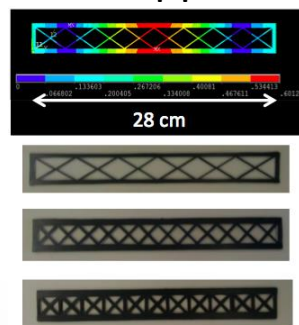
signal simulations



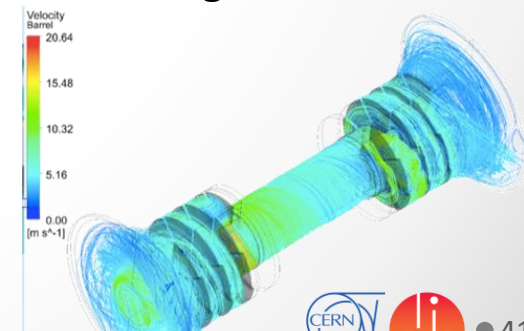
power delivery + pulsing



thin supports



air cooling simulations/tests



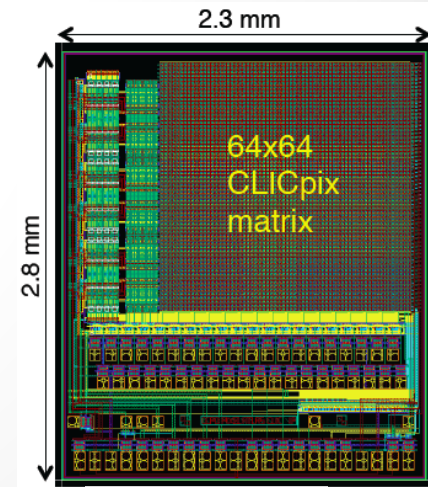
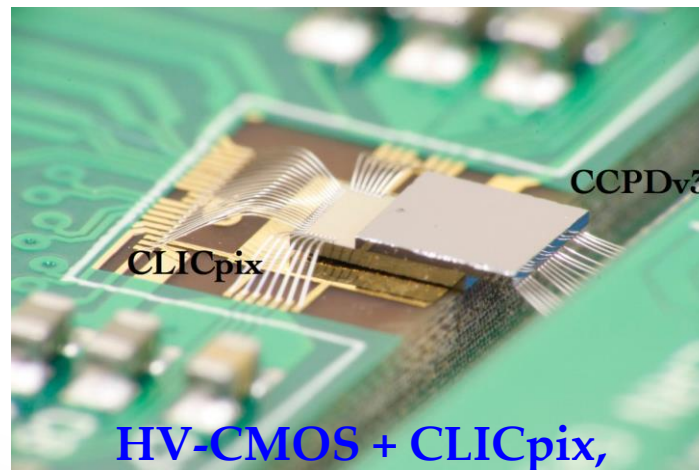
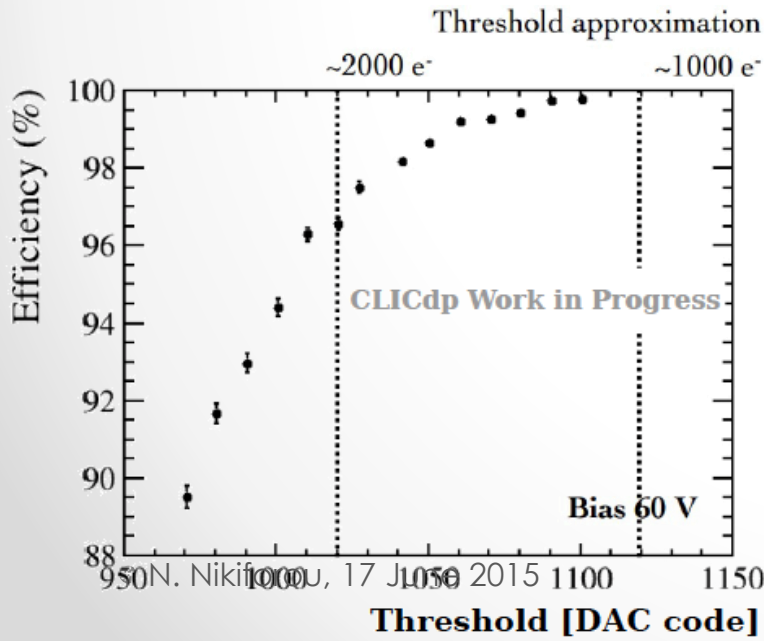
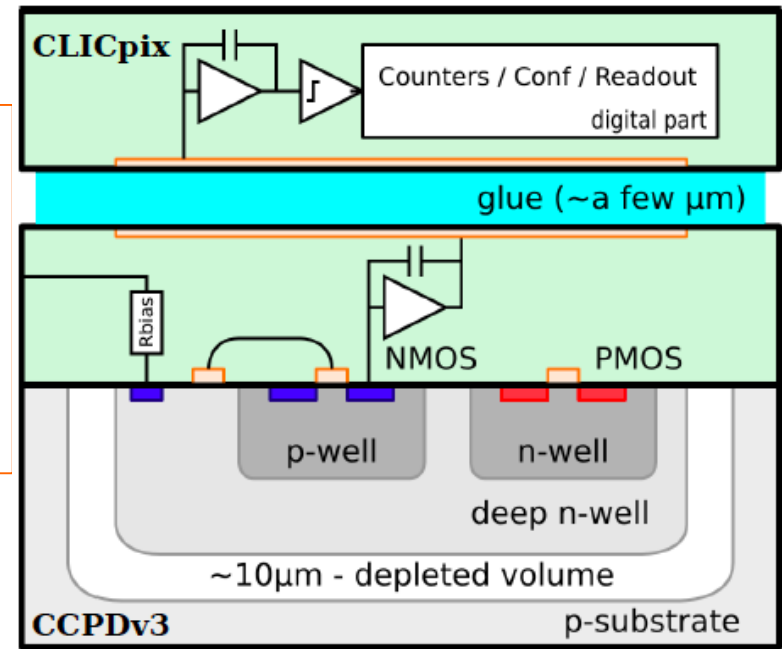
Hybrid Vertex Detector with HV-CMOS

Pursuing an alternative readout option

Hybrid option with High Voltage-CMOS:
 Capacitive Coupled Pixel Detector (CCPD)

- HV-CMOS chip as integrated sensor + amplifier
- Capacitive coupling to CLICpix readout chip through layer of glue \Rightarrow no bump bonding

Status: successful initial beam tests in 2014
 Further beam tests in 2015



**HV-CMOS + CLICpix,
AC coupled**

CCPDV3

CLIC Vertex Detector R&D Roadmap 43

Hybrid approach pursued: (<= other options possible)

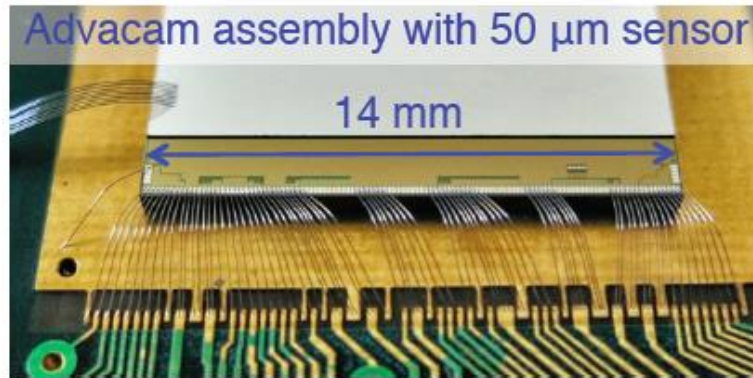
- Thin (~50 μm) **silicon sensors**
- Thinned high-density **readout ASIC** (50 μm)
 - R&D within Medipix/Timepix effort
- **Low-mass interconnect**
- **Power pulsing**
- **Air cooling**

CLICpix demonstrator ASIC
64×64 pixels, fully functional

- 65 nm technology
- 25×25 μm^2 pixels
- 4-bit ToA and ToT info
- Data compression
- Pulsed power: 50 mW/cm²

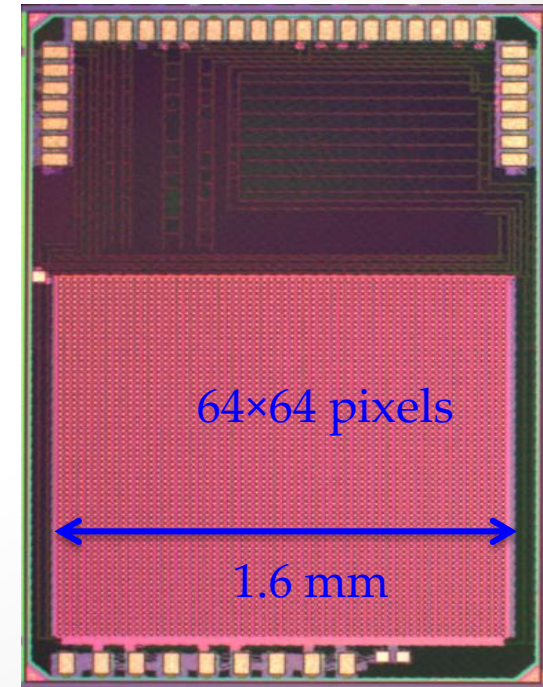


50 μm dummy wafer



Very thin sensors !

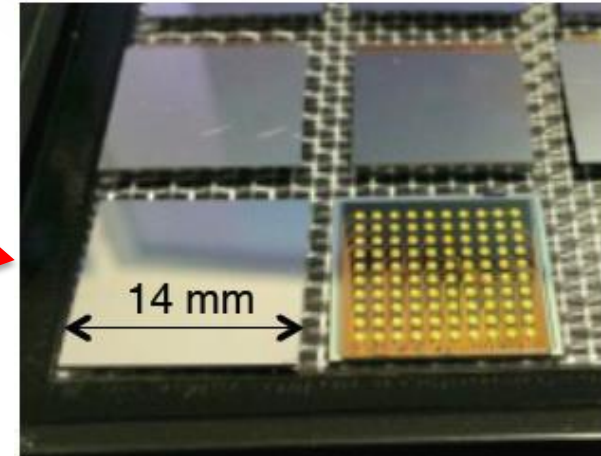
Successfully tested at DESY test beam
(with existing Timepix ASIC)



CLIC vertex detector: thin assemblies

Ultimate aim:

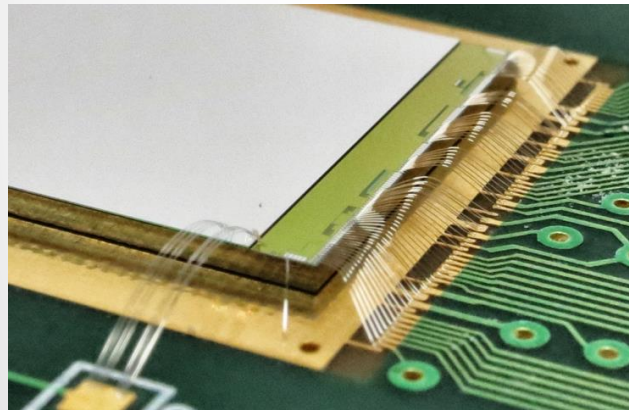
- 50 μm sensor on 50 μm ASIC
- Slim-edge sensors
- Through-Silicon Vias (TSV)
 - eliminates need for wire bonds
 - 4-side buttable chip/sensor assemblies
 - large active surfaces => less material



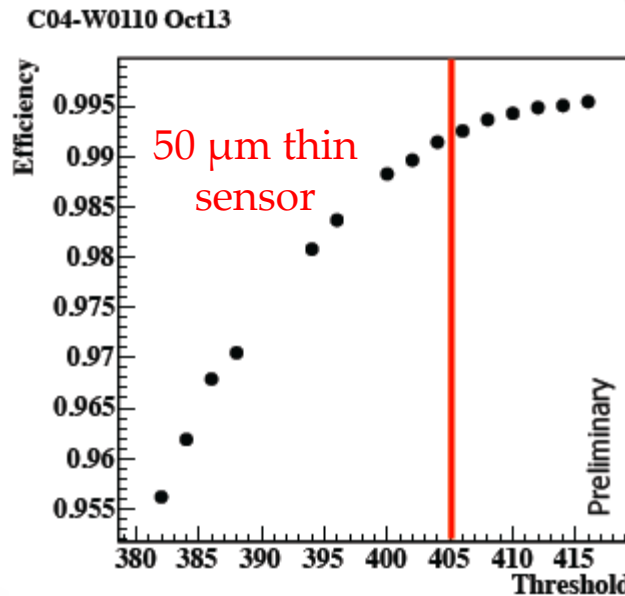
Medipix3RX with TSV
by CEA LETI



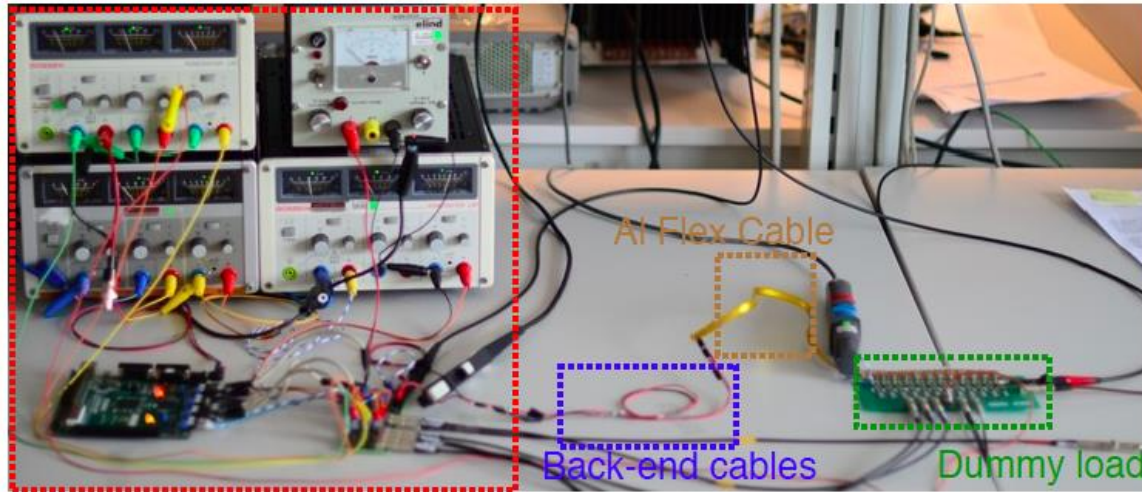
First successful picture using Medipix3RX with



50 μm thin sensor on Timepix tested at test beam !



CLIC Vertex R&D: Power Pulsing



Controlled current source

Design for low mass !

- Power pulsing with local energy storage in Si capacitors and voltage regulation with Low-Dropout Regulators (LDO)
- FPGA-controlled current source provides small continuous

current
Local material: now $0.1\%X_0/\text{layer}$, can be reduced to $0.04\%X_0/\text{layer}$ (Si-capacitor technology)

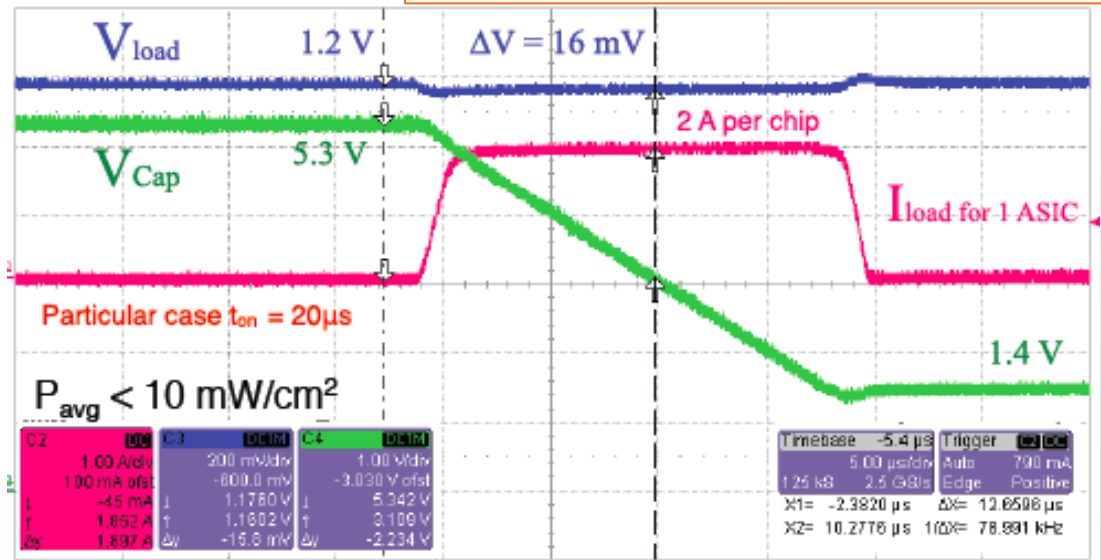
Analog:

- Voltage drop ~ 16 mV
- Measured average power dissipation < 10 mW/cm²

Digital

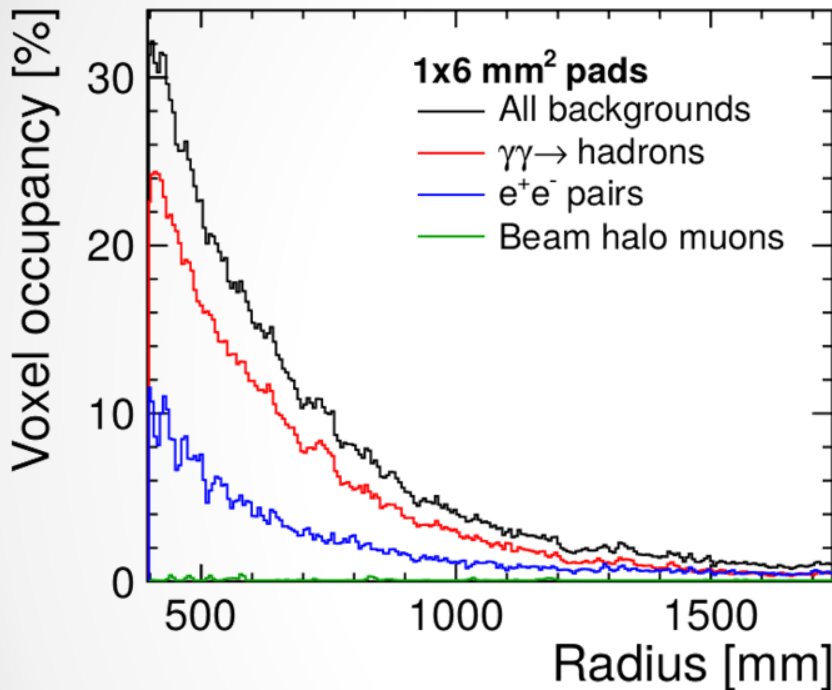
- Voltage drop ~ 70 mV
- Measured average power dissipation < 35 mW/cm²

Total dissipation < 50 mW/cm²

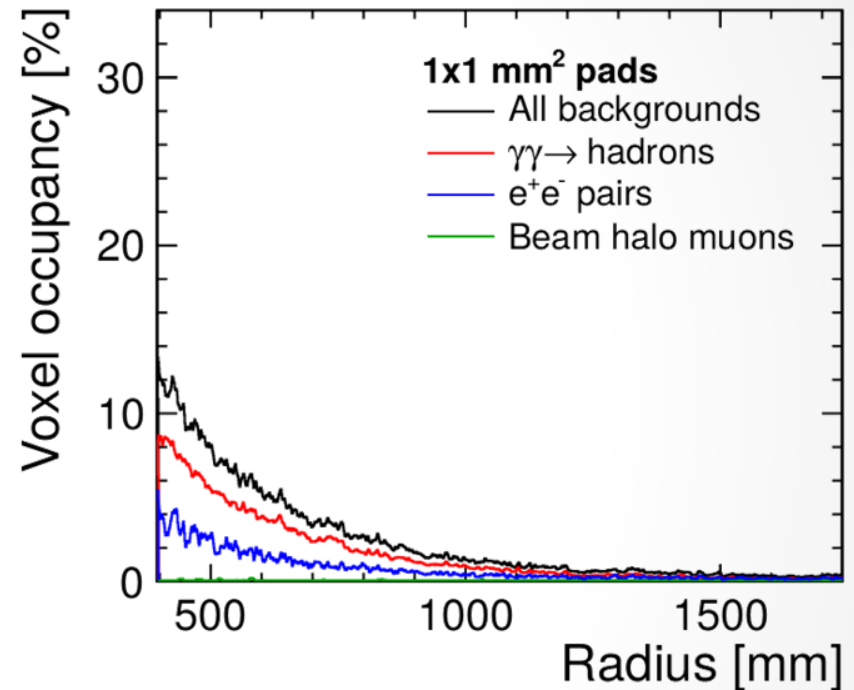


TPC Occupancy in CLIC_ILD

From CDR. See also [LCD-Note-2011-029](#) [11]



(a) Voxel occupancies for 1×6 mm² pads



(b) Voxel occupancies for 1×1 mm² pads

Fig. 5.11: Voxel occupancies for different pad sizes, averaged per pad row in the TPC for particles originating from $\gamma\gamma \rightarrow$ hadrons, incoherent pairs and beam-halo muons. The data correspond to one complete bunch train and do not include safety factors.

PFA Calorimetry at CLIC

Technology (CDR)

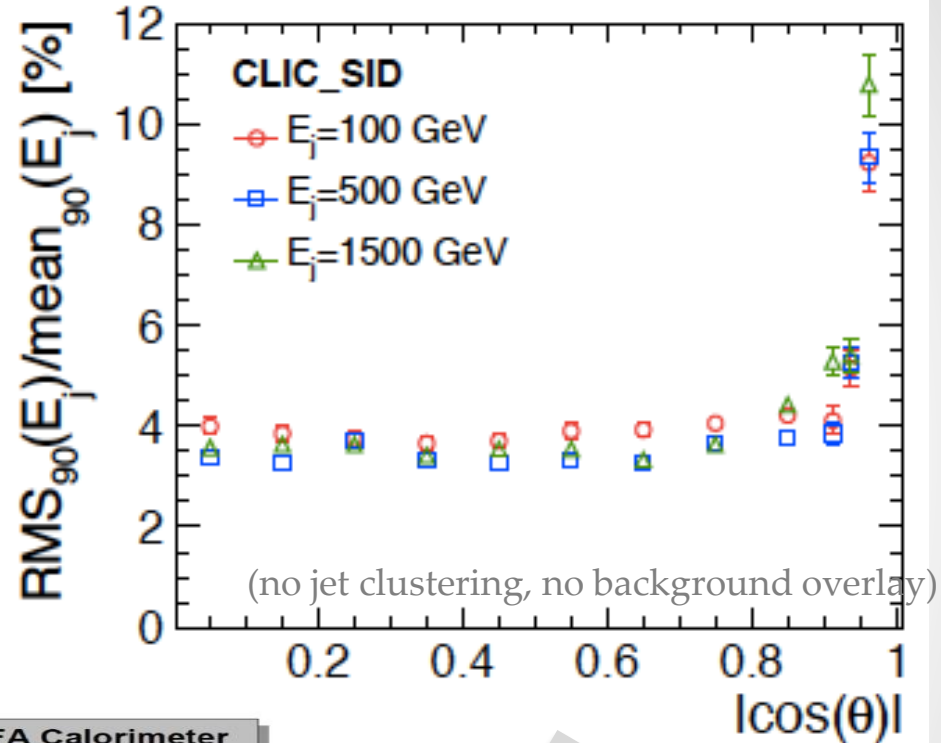
ECAL

Silicon (active) + Tungsten (absorber)
cell sizes $\sim 25 \text{ mm}^2$
30 layers in depth ($\sim 23 X_0$)

HCAL

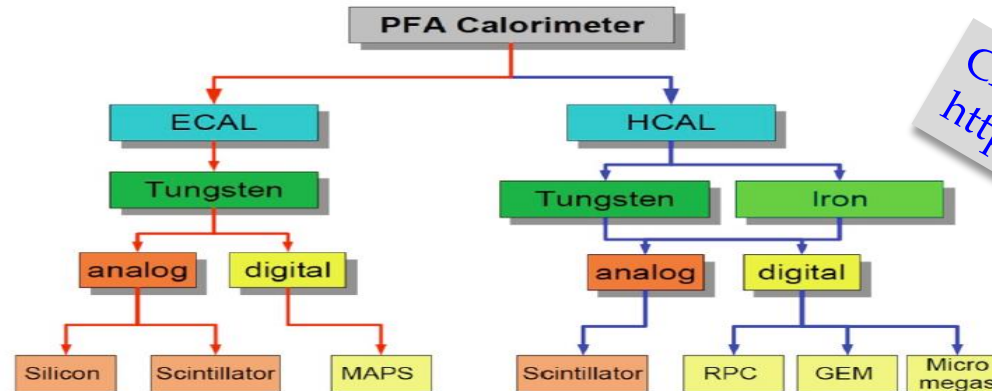
Scintillator+SiPM (active)
Tungsten (barrel), steel (endcap)
cell sizes 9 cm^2 (analog)
75/60 layers in depth
Total depth $7.5 \Lambda_i$

simulated jet energy resolution



many technologies pursued

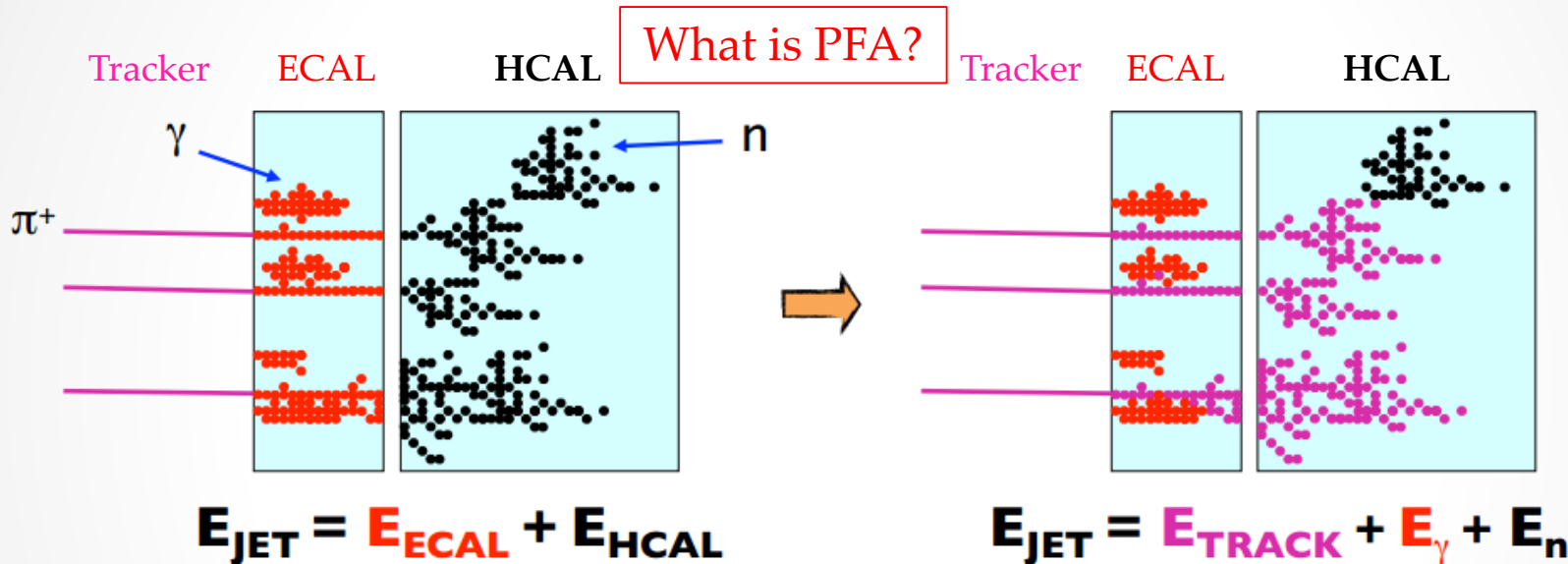
• N. Nikiforou, 17 June 2015



CALICE collaboration
<http://fcal.desy.de/>

Calorimetry and PFA

Jet energy resolution and background rejection drive the overall detector design
⇒ fine-grained calorimetry + Particle Flow Algorithm (PFA)



Typical jet composition:
60% charged particles
30% photons
10% neutral hadrons

Always use the best info you have:

60% ⇒ tracker 😊 😊
30% ⇒ ECAL 😊
10% ⇒ HCAL 😞

Hardware + software !

Calorimeter R&D

- **Developing high-granularity calorimeters**

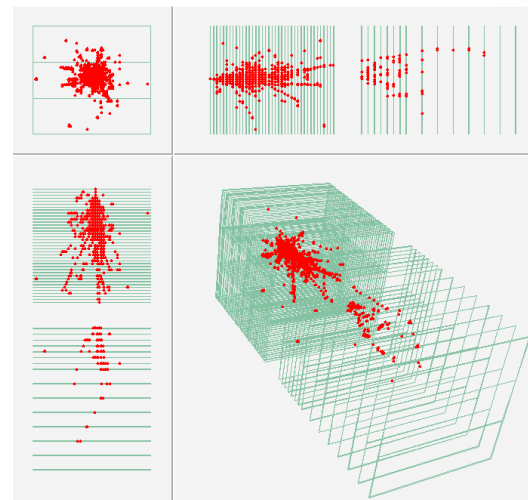
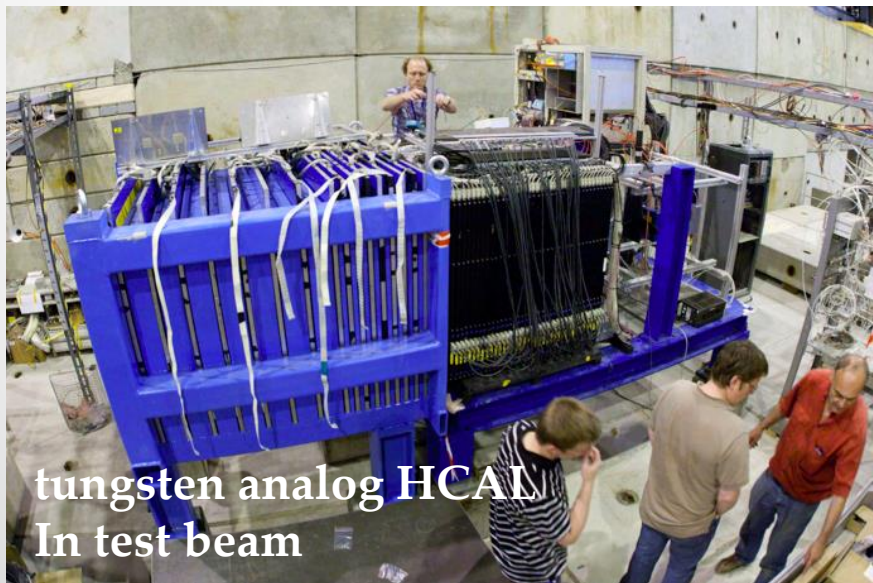
- ~80 million readout channels
- (400x larger than LHC)

- To be used with Particle Flow Algorithm

- R&D in the framework of **CALICE** collaboration

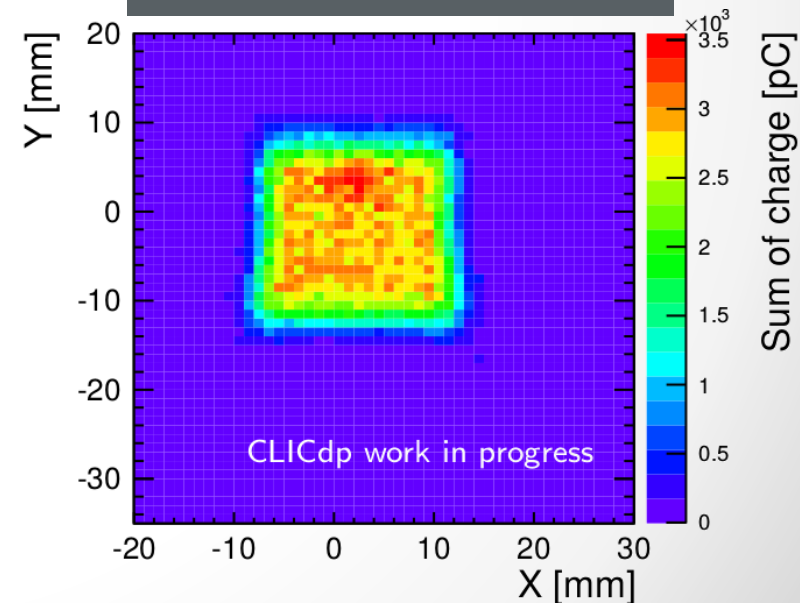
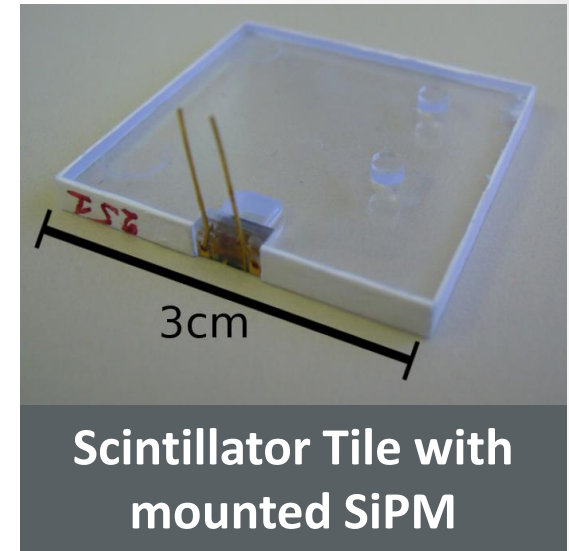
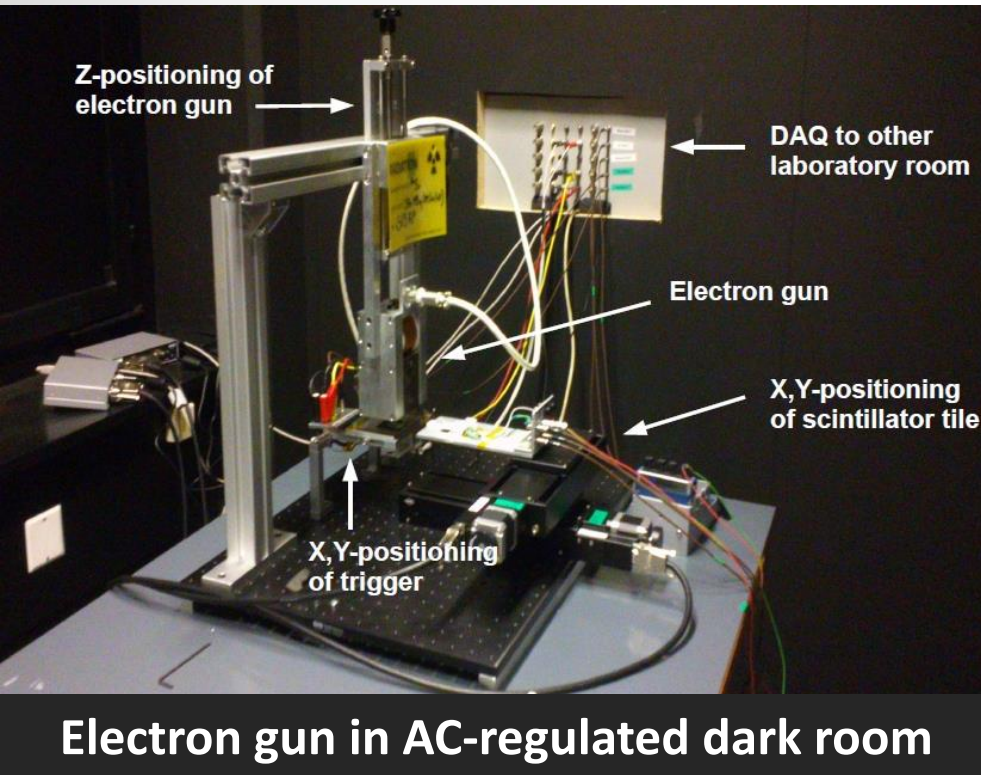
- Investigating different absorber materials, readout technologies and techniques

	# layers	cell sizes	technology option
ECAL	~25	5×5 mm ²	Silicon
HCAL	~60	3×3 cm ²	Scintillator + SiPM



210 GeV π^- in tungsten-DHCAL

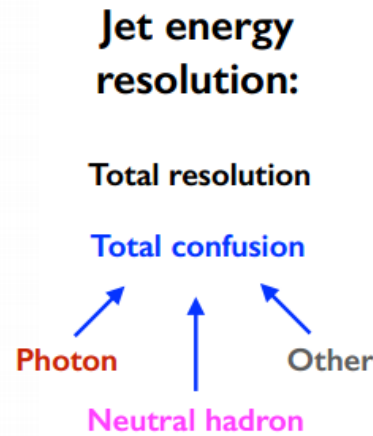
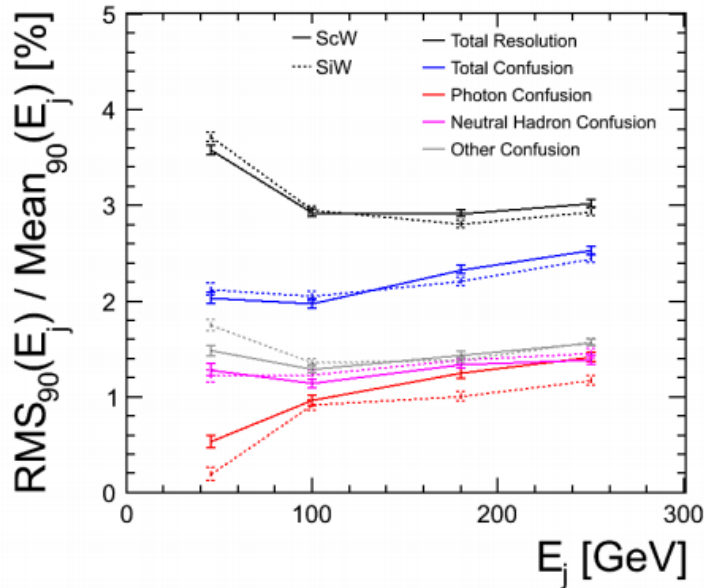
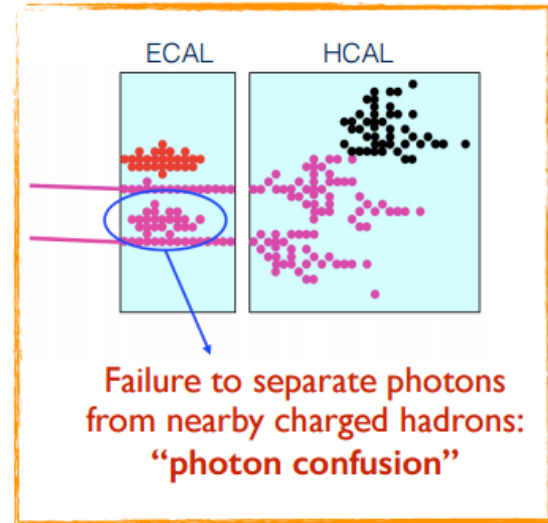
R&D on Scintillator+SiPM



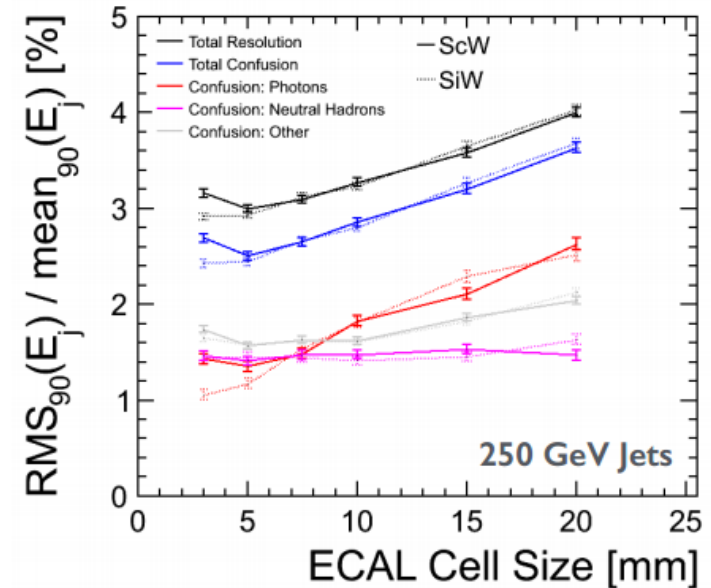
- Also have a dedicated lab at CERN for **Scintillator** + **Silicon PhotoMultiplier** testing
- Test bench: **electron gun**, **Device Under Test** on **movable table**, **trigger scintillators**, **read-out electronics**
- Study response, uniformity, noise, cross-talk, ...

ECAL Optimization (J.S. Marshall [12])

- Starting point: 29 layers W absorber ($23X_0, 1\lambda_1$), 30 layers Si active medium (1 pre-sampler), divided into $5 \times 5 \text{mm}^2$ pixels.
- Particle flow means performance depends critically on pattern-recognition, not just intrinsic ECAL energy resolution.
- Granularity requirements and use of Si make ECAL expensive: consider scintillator (Sc) with SiPM readout as active medium.
- Examined wide range of ECAL models, developing detailed understanding of resulting jet energy resolutions.



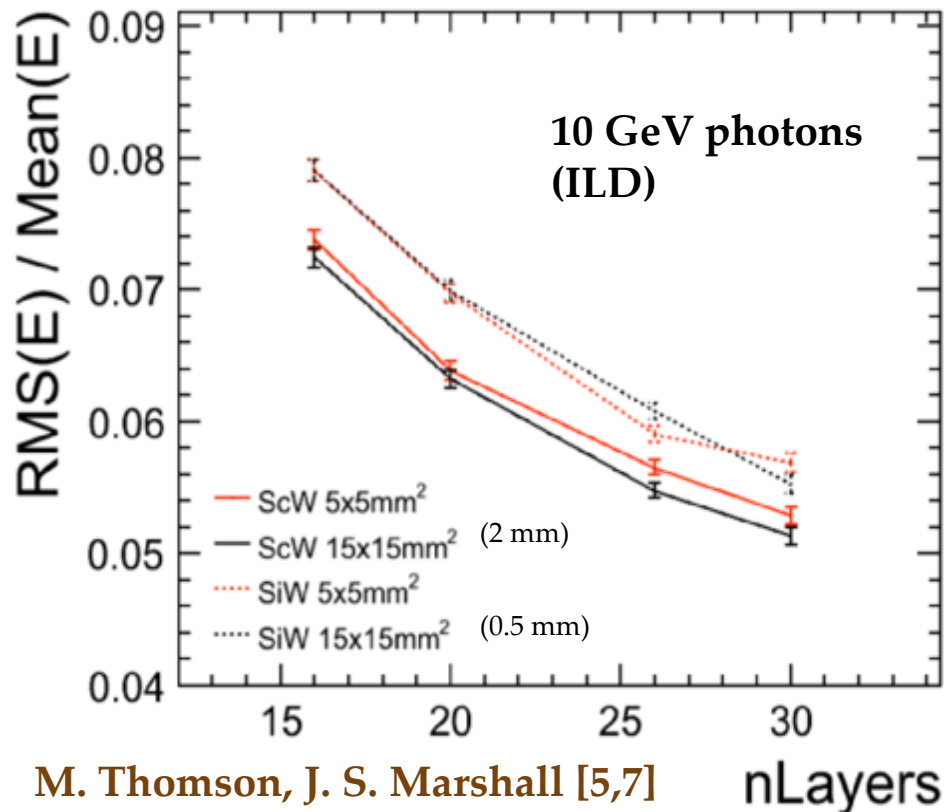
[51]



Ecal Optimization: Active Material, Number of Layers, Granularity

ILD-based baseline model: SiW ECal with 29 layers ($23 X_0 / 1 \lambda_I$):

- Tungsten absorber: 20x2.1 mm + 9x 4.2 mm
- Silicon Active material, 500 μm thickness, 5x5 mm^2 cells



- Scintillator instead of silicon may give a slightly better resolution
 - Depends on active element thickness
 - Also considered Si/Sc combinations
- Stronger dependence on number of layers ($\sim 1/\sqrt{N}$)

M. Thomson, J. S. Marshall [5,7]

Forward Calorimetry

R&D performed within the FCAL collaboration

2 forward calorimeters:

- LumiCal + BeamCal
- Electron / photon acceptance to small angles
- Luminosity measurement
- Beam feedback

Absorbers: tungsten, 40 layers of $1 X_0$

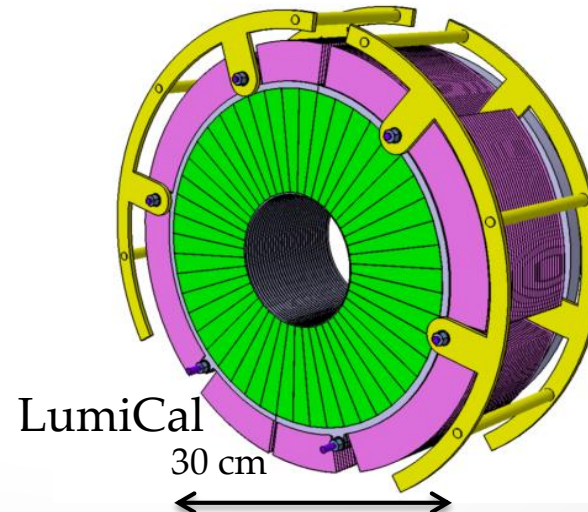
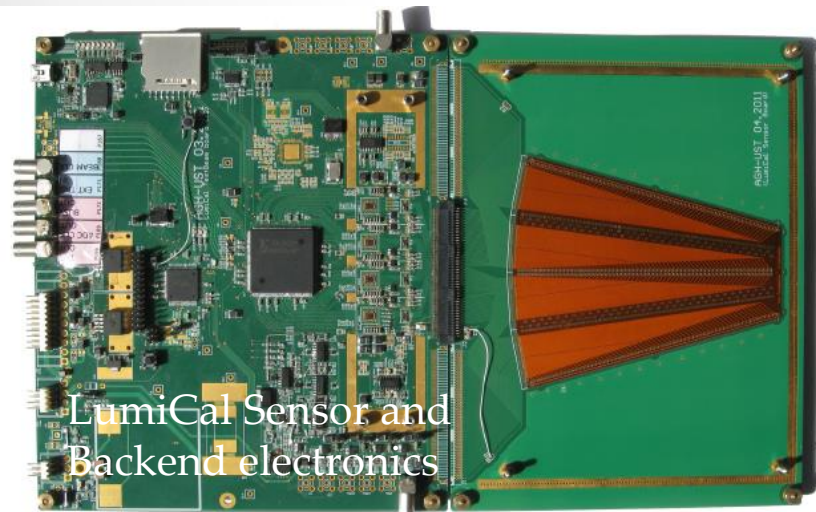
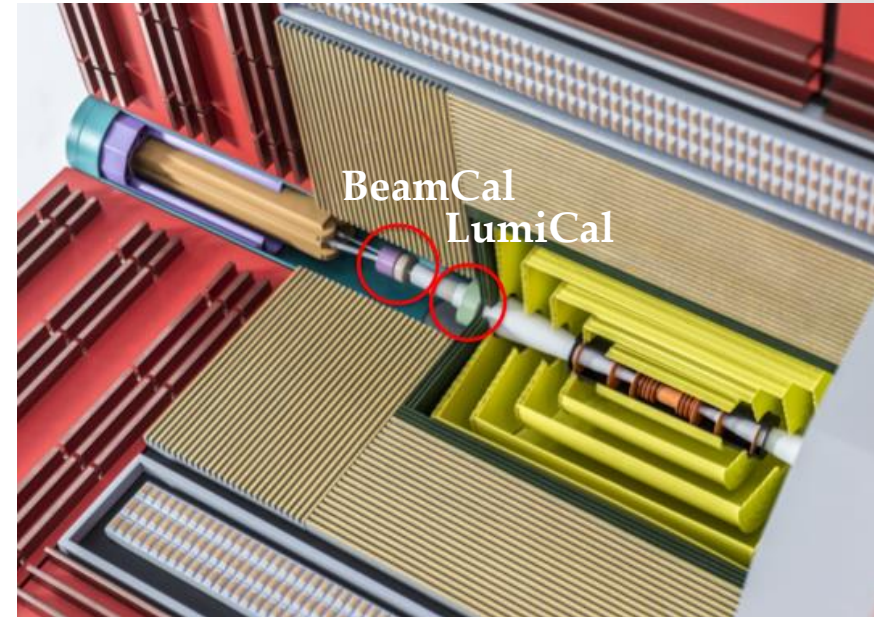
Sensors: BeamCal GaAs, LumiCal silicon

Angular coverage:

BeamCal 10 - 40 mrad, LumiCal 38 – 110 mrad

Doses up to 1 MGy

Neutron fluxes of up to 10^{14} per year



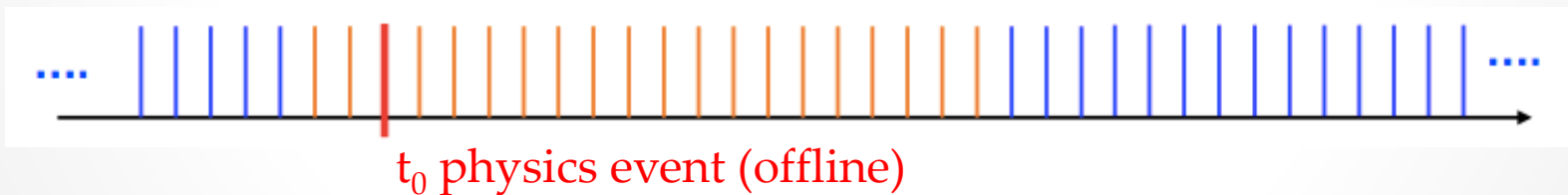
Very compact !

FCAL collaboration
<http://fcal.desy.de/>

Time window / time resolution

The event reconstruction software uses:

Subdetector	Reconstruction window	hit resolution
ECAL	10 ns	1 ns
HCAL Endcaps	10 ns	1 ns
HCAL Barrel	100 ns	1 ns
Silicon Detectors	10 ns	$10/\sqrt{12}$ ns
TPC	entire bunch train	n/a



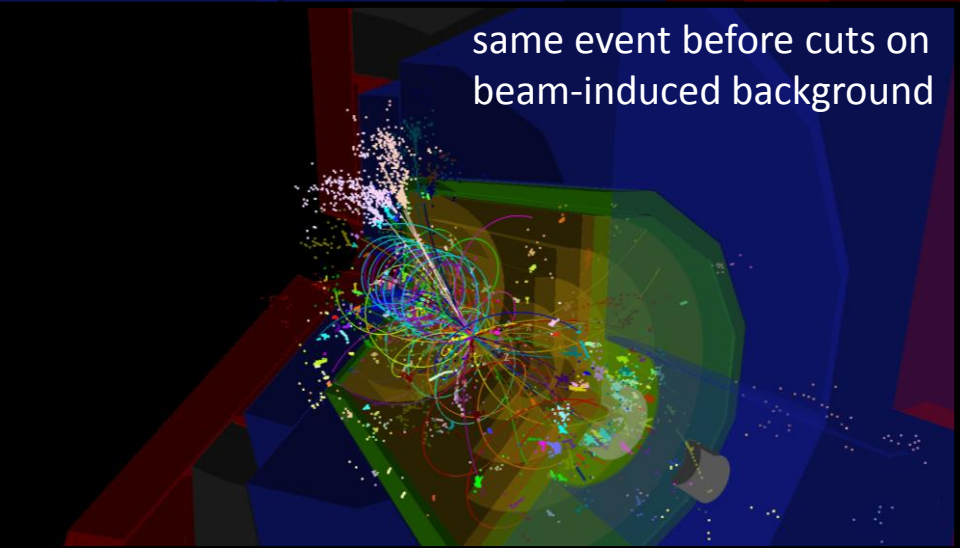
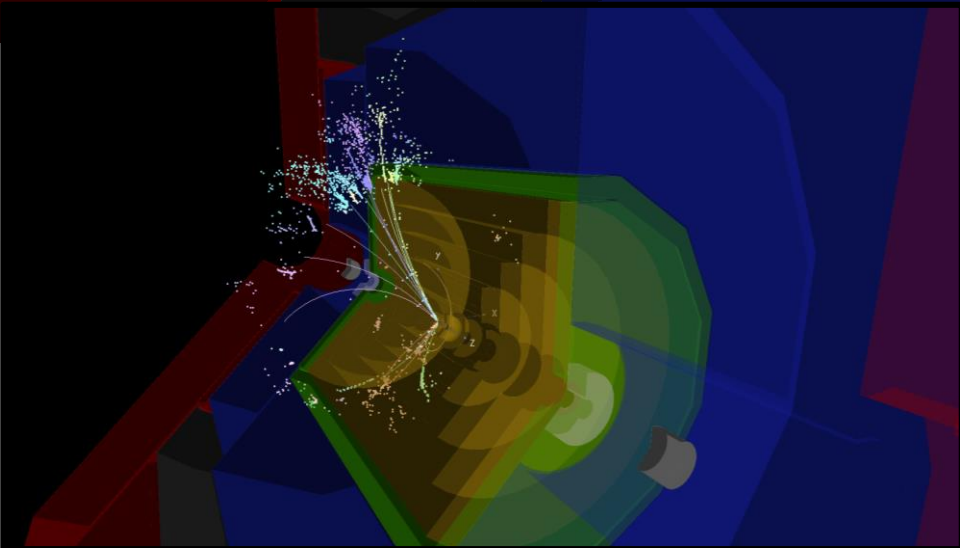
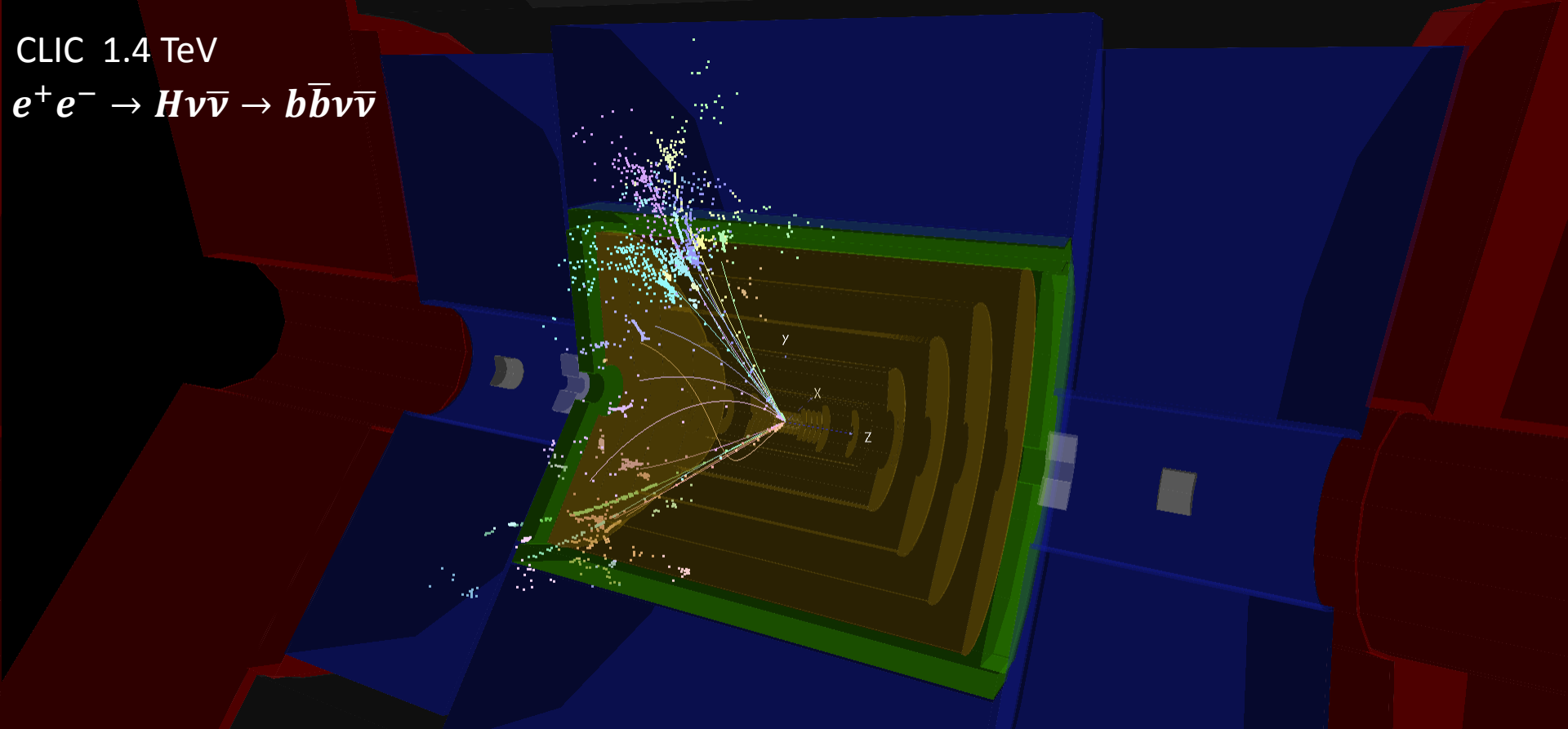
Translates in precise **timing requirements** of the sub-detectors

PFO-based Timing Cuts

<i>Region</i>	<i>p_t range</i>	<i>Time cut</i>
Photons		
central ($\cos \theta \leq 0.975$)	$0.75 \text{ GeV} \leq p_t < 4.0 \text{ GeV}$ $0 \text{ GeV} \leq p_t < 0.75 \text{ GeV}$	$t < 2.0 \text{ nsec}$ $t < 1.0 \text{ nsec}$
forward ($\cos \theta > 0.975$)	$0.75 \text{ GeV} \leq p_t < 4.0 \text{ GeV}$ $0 \text{ GeV} \leq p_t < 0.75 \text{ GeV}$	$t < 2.0 \text{ nsec}$ $t < 1.0 \text{ nsec}$
Neutral hadrons		
central ($\cos \theta \leq 0.975$)	$0.75 \text{ GeV} \leq p_t < 8.0 \text{ GeV}$ $0 \text{ GeV} \leq p_t < 0.75 \text{ GeV}$	$t < 2.5 \text{ nsec}$ $t < 1.5 \text{ nsec}$
forward ($\cos \theta > 0.975$)	$0.75 \text{ GeV} \leq p_t < 8.0 \text{ GeV}$ $0 \text{ GeV} \leq p_t < 0.75 \text{ GeV}$	$t < 2.0 \text{ nsec}$ $t < 1.0 \text{ nsec}$
Charged PFOs		
all	$0.75 \text{ GeV} \leq p_t < 4.0 \text{ GeV}$ $0 \text{ GeV} \leq p_t < 0.75 \text{ GeV}$	$t < 3.0 \text{ nsec}$ $t < 1.5 \text{ nsec}$

CLIC 1.4 TeV

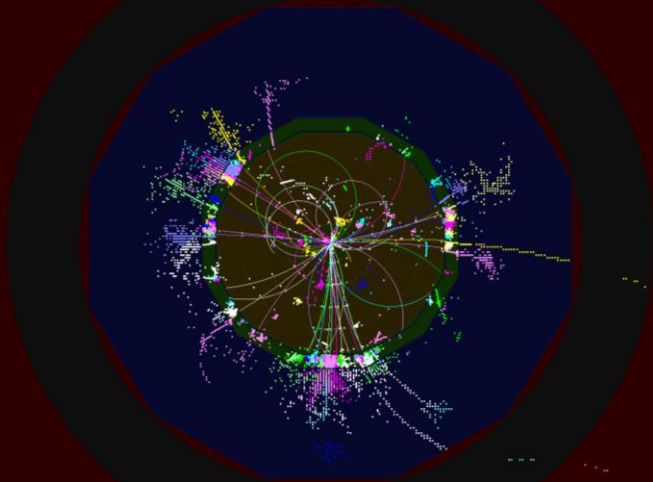
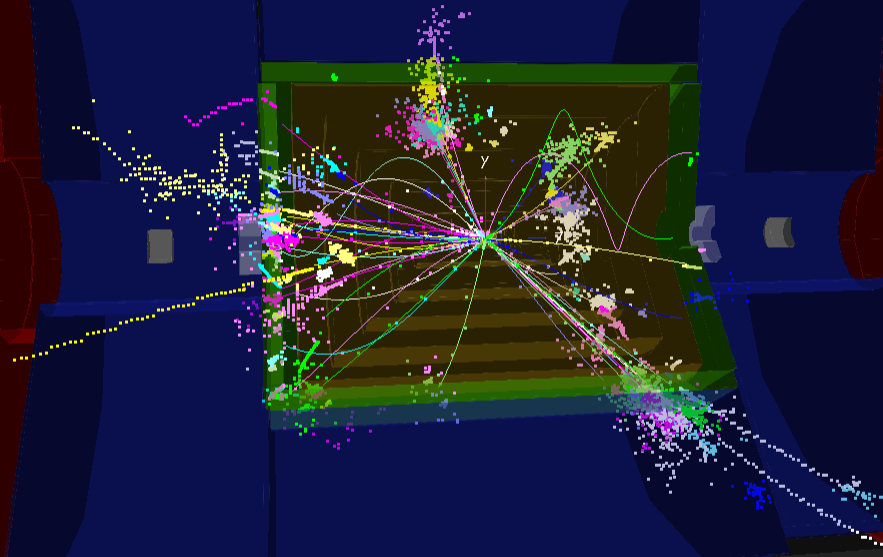
$e^+e^- \rightarrow H\nu\bar{\nu} \rightarrow b\bar{b}\nu\bar{\nu}$



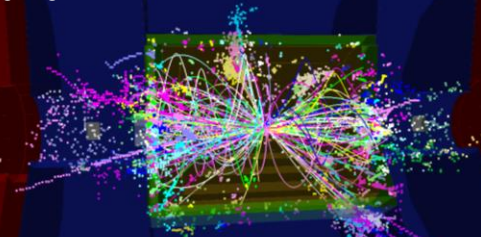
same event before cuts on
beam-induced background

CLIC 1.4 TeV

$e^+e^- \rightarrow t\bar{t}H \rightarrow WbW\bar{b}H \rightarrow q\bar{q}b\tau\nu\bar{b}b\bar{b}$

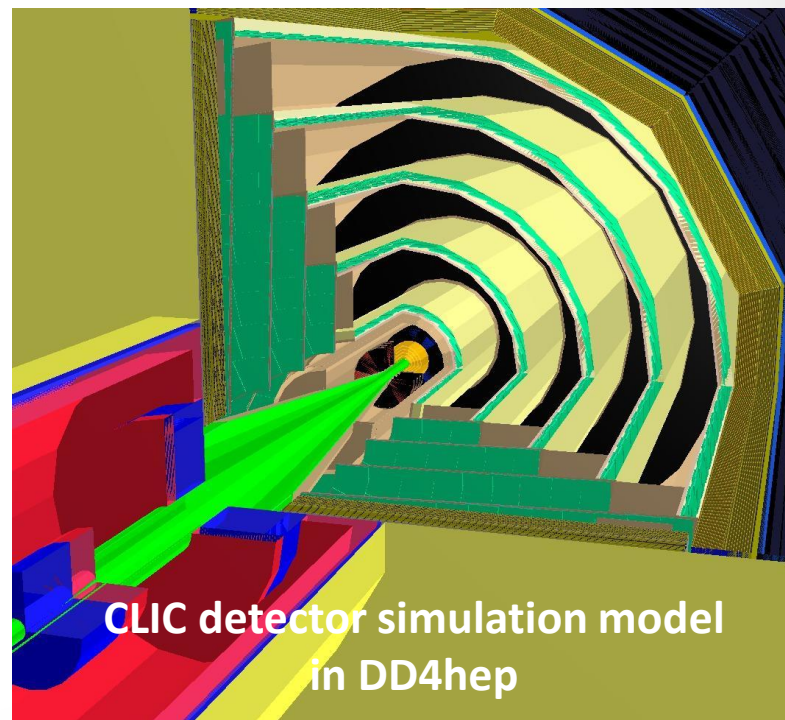
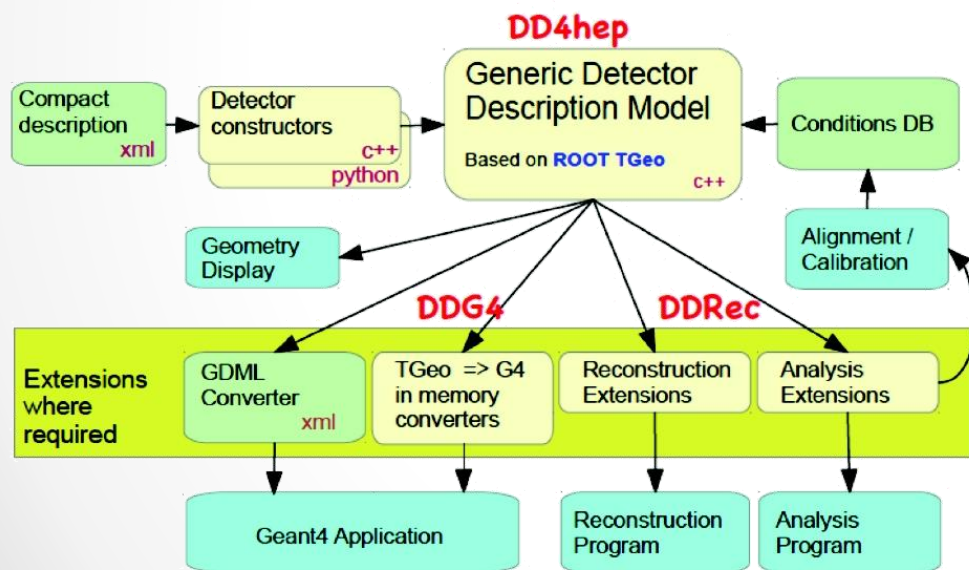


same event before cuts on beam-induced background



HEP Software Development

- Strong involvement with **simulation and reconstruction software** development in collaboration with ILC
- Developing and maintaining the **ILCDirac** grid computing framework
- Developing a new **Detector Geometry Description and Simulation Framework: Detector Description 4 HEP (DD4hep)**
 - Will be used by others too: ILC, FCC, LHCb, ...



Schematic overview of the DD4hep framework